

**Разработка и создание резистивных  
микроструктурных газоразрядных детекторов  
(R-MPGD) для экспериментов  
в физике высоких энергий,  
проводимых в ОИЯИ**

Докладчик:

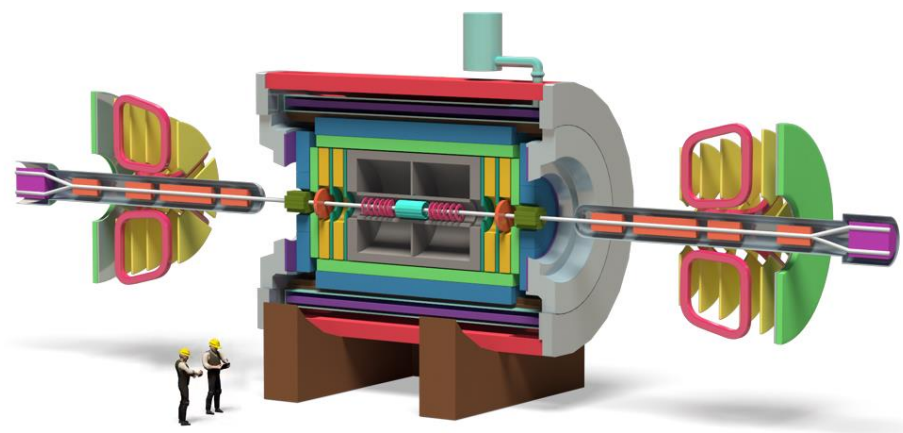
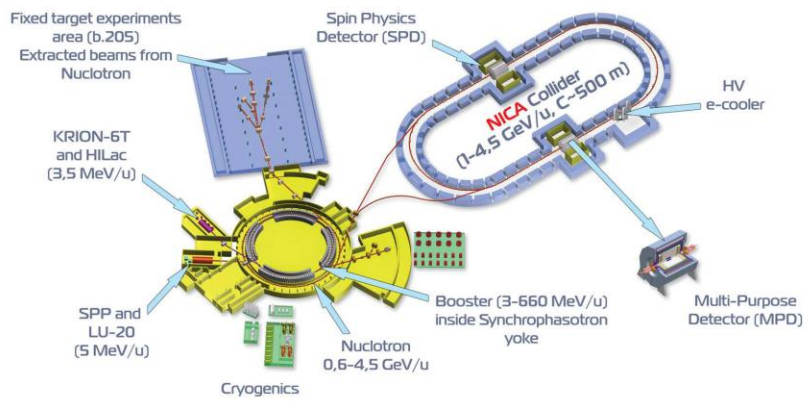
**Баев Вадим Геннадьевич**

*Зав. Сектором научно-технического  
сотрудничества*

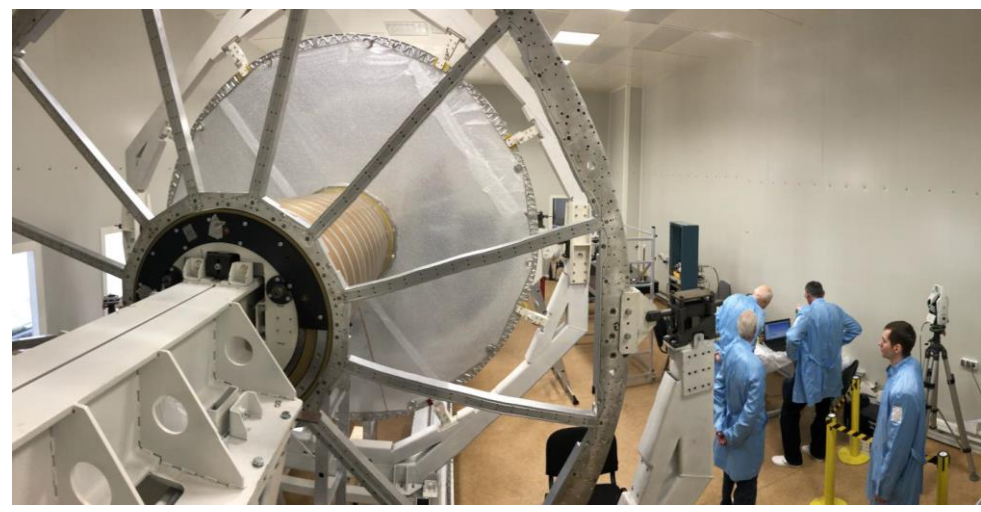
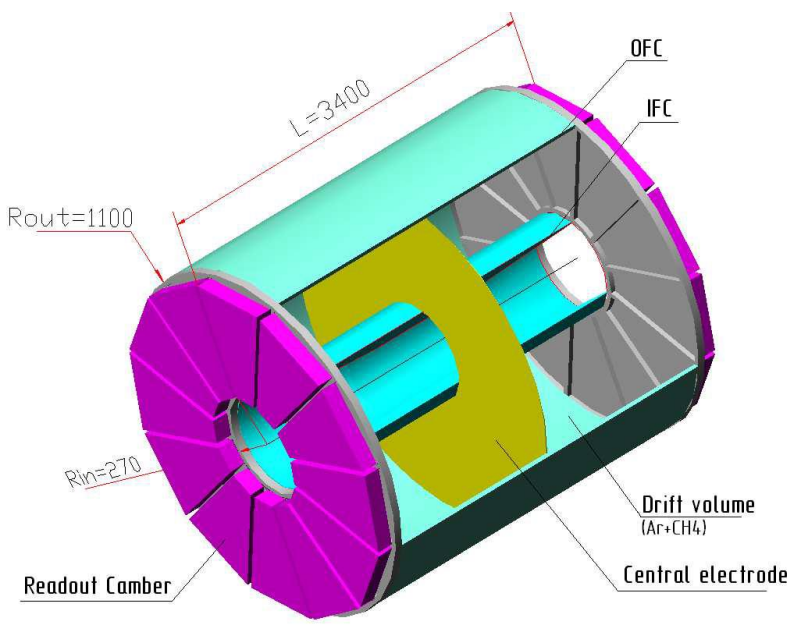
*Институт энергетики  
Национальной академии наук Беларуси*

# TPC of MPD experiment at Nuclotron-based Ion Collider Facility (NICA)

Scheduled Launch in 2025



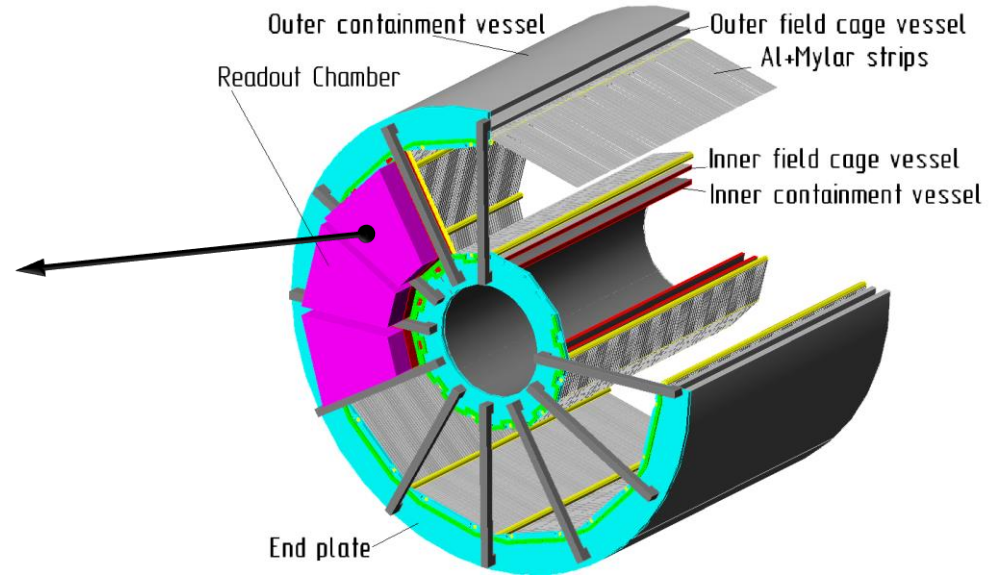
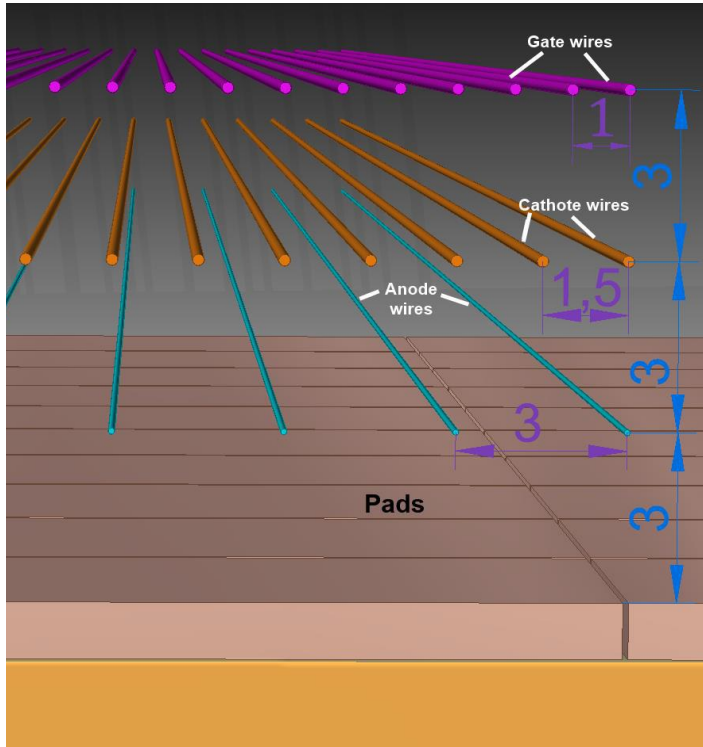
### Multi-Purpose Detector (MPD)



### Time Projection Chamber (TPC)

# Read-Out Chamber of 1<sup>st</sup> Stage of NICA MPD Experiment

## MultiWire Proportional Chamber (MWPC) with Gating Grid System



At the 2d Stage of NICA MPD Experiment the Luminosity will be increased. It means that Event Rate of R/O Chambers should be also increased → Upgrade by use of

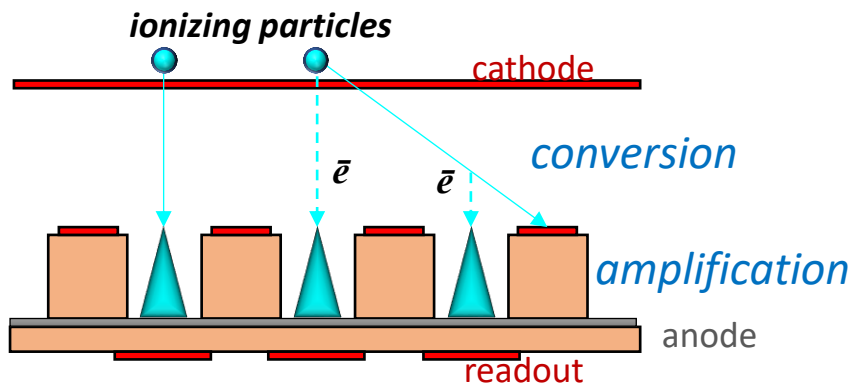
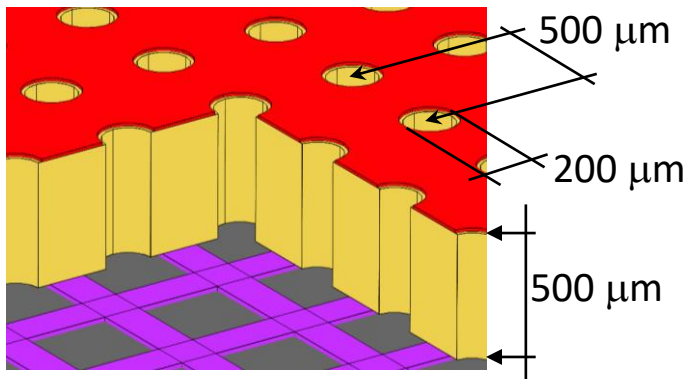
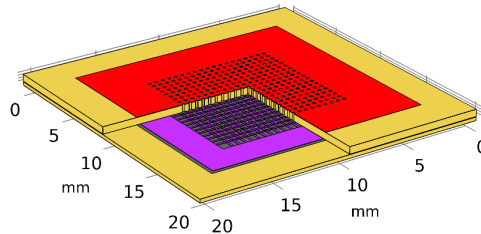
**Micro Pattern Gaseous Detectors (MPGDs)**

Parameter of 1 <sup>st</sup> Stage	Value
Length of the TPC	340cm
Outer radius of vessel	140cm
Inner radius of vessel	27 cm
Maximum beam-beam event rate	<b>5 kHz</b>
Luminosity	$1 \cdot 10^{27} \text{ cm}^{-2}\text{s}^{-1}$
Gas amplification factor	10,000

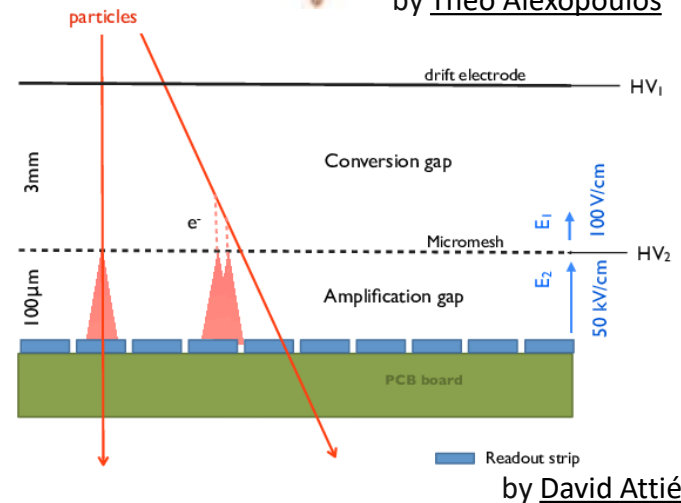
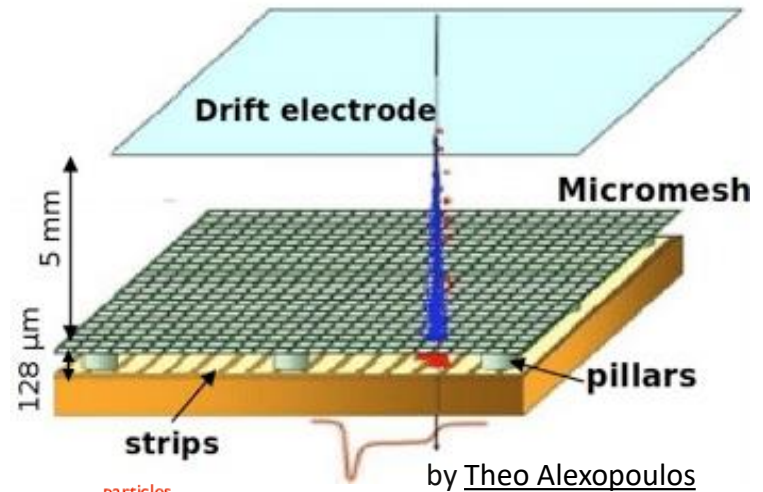
# Micro Pattern Gaseous Detectors (MPGDs)

MPGDs is a new generation of radiation detector devices with promising performance not only for the High Energy Physics experiments, but also for many other applications as medical, imaging, dosimetry, muon tomography etc.

## Resistive Well Electron Multiplier (R-WEM)



## MicroMegas detector

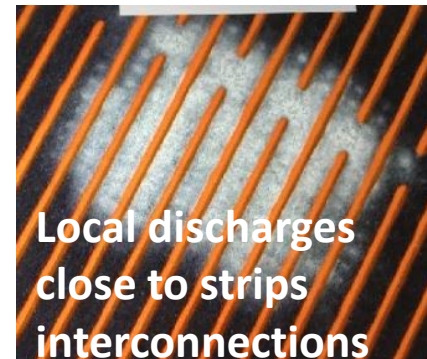




# A Key Role of Discharge Robustness

The results of FLUKA simulation of NICA TPC estimate the fluence of highly ionizing particles (ions, recoils) to be up to  **$10^6$  per  $\text{cm}^2$  per year**

## Degradation of wires after discharges

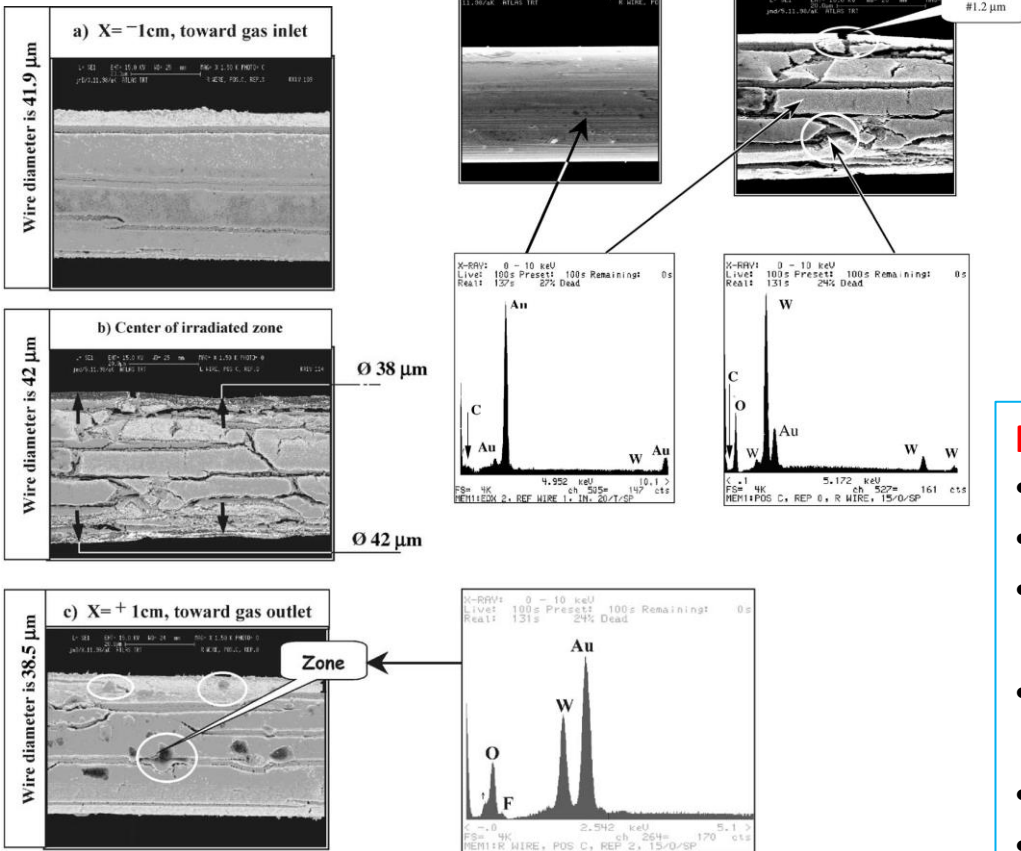


Destruction of resistive strips (resistive paste) in Micromegas chambers for the ATLAS New Small Wheel upgrade

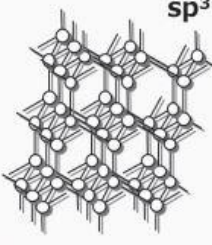
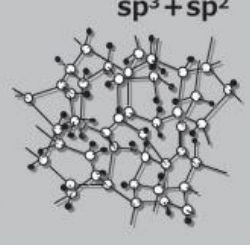
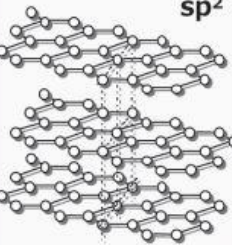
<https://cds.cern.ch/record/2712020/files/ATL-MUON-SLIDE-2020-062>

### Negative consequences of electrical discharges:

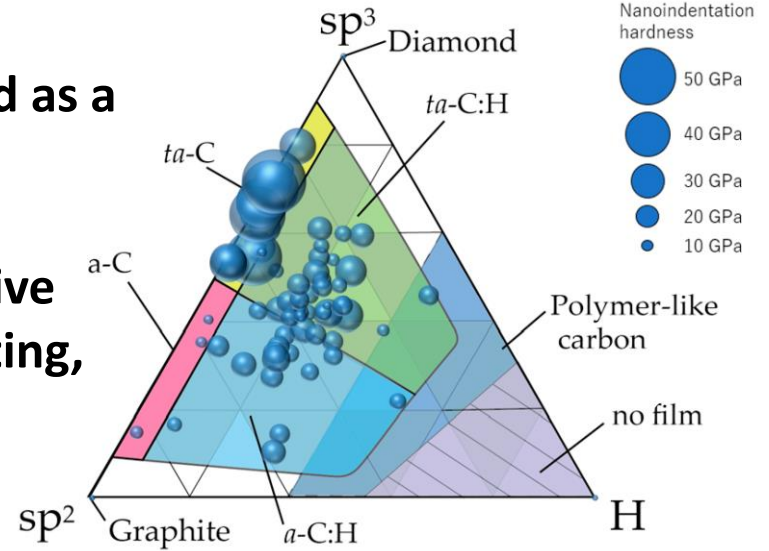
- material degradation
- damage to the amplification structure
- reduction of gas gain due to local voltage drop
- irreversible changes in the detector parameters (energy resolution, gas gain)
- dead time due to local voltage drop
- saturation of the readout electronics



# DLC – Diamond-Like Carbon

Diamond	D L C (Diamond-like carbon )	Graphite
$sp^3$	$sp^3 + sp^2$	$sp^2$
		

Widely used as a  
hardening  
coating,  
anti-reflective  
optical coating,  
decorative

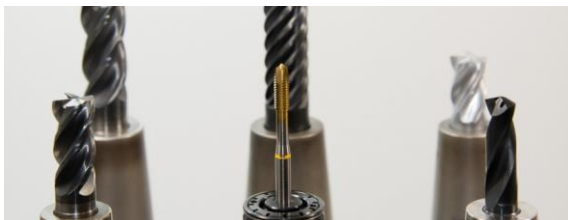


uploaded from pcs-instruments.com



by Naoto Ohtake *Materials* 2021, 14(2)

In High Energy Physics  
is used as a resistive  
coating for MPGDs



# The use of Diamond-Like Carbon Coating as a Resistive Anode in Micro Pattern Gaseous Detectors for High Energy Physics



- *Joint Institute for Nuclear Research*
- *Institute of Power Engineering of National Academy of Sciences of Belarus*
- *Physical-Technical Institute of National Academy of Sciences of Belarus*

Development and research of Micro Pattern Gaseous Detectors with resistive DLC anode for MPD and SPD experiments of accelerator complex NICA

DLC coating is used in R&D of:

**MicroMegas** detector (Micromesh Gaseous Structure)

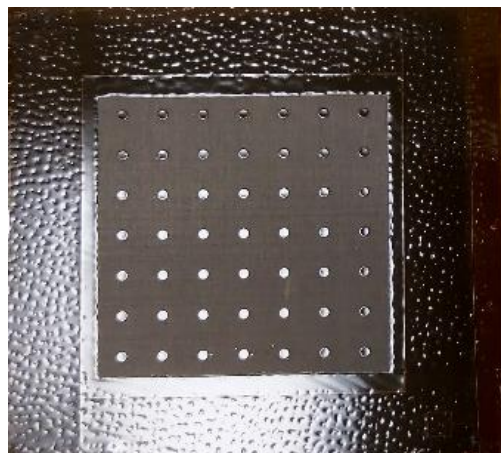
**R-WEM** detector (Resistive Well Electron Multiplier)

**Straw-detector** with cathode read-out

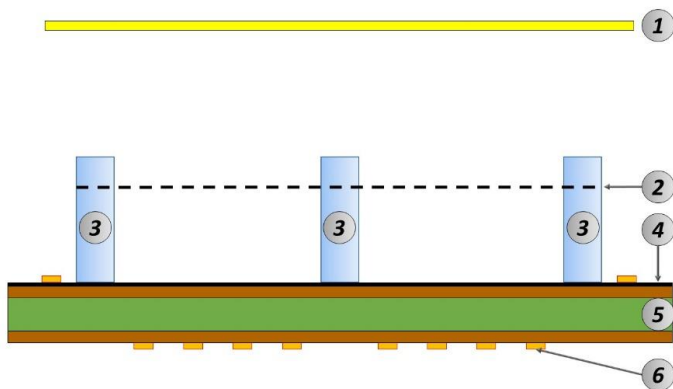
- **DLC coating** (of thickness about **100 nm**) increase the robustness to discharges by highly ionizing particles (ions, recoils).
- **Sheet resistance** is varied from **500 kΩ per square** to **1 GΩ per square** (**Resistivity 0.1 Ω·cm – 5 kΩ·cm**).
- **Uniformity** is 85% at the area 20cmX20cm and 90% at the area 10cmX10cm.
- **Stable parameters** of Micro Pattern Gaseous Detectors after more than 10M discharges at the area 10cmX10cm
- **The maximum area** is 400 mm X 800 mm

**Cooperation agreement N332** between **Joint Institute for Nuclear Research** and **Institute of Power Engineering of the National Academy of Sciences of Belarus**

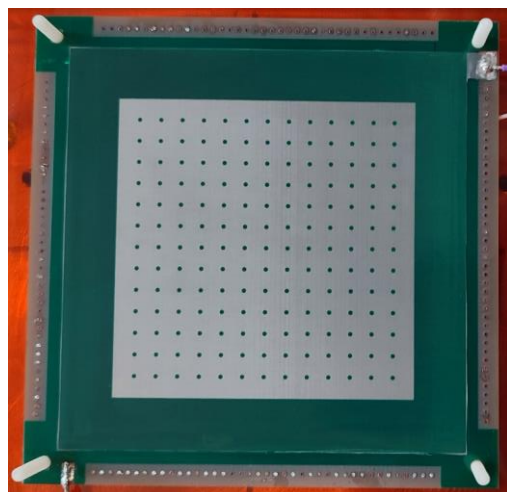
# MicroMegas detector with the resistive DLC anode



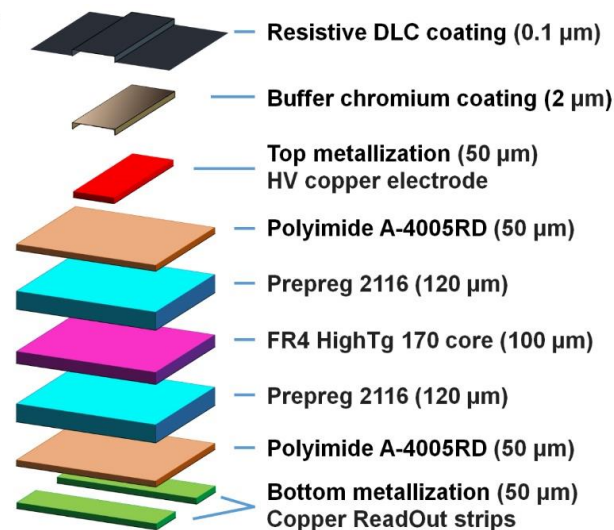
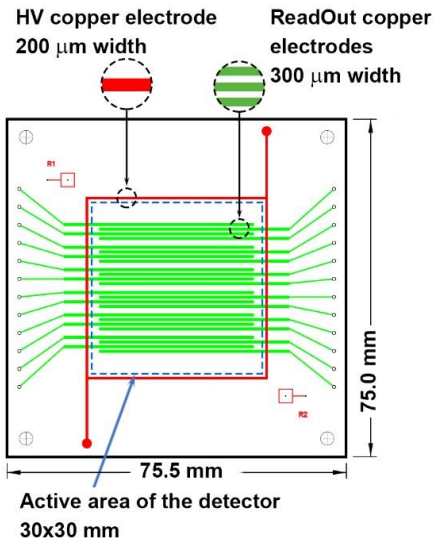
Prototype with active area 30mm x 30mm



- (1) cathode
- (2) stainless steel mesh with wire of 18  $\mu\text{m}$  in diameter and the pitch of 63  $\mu\text{m}$
- (3) support pillars
- (4) resistive DLC layer anode
- (5) multilayered printed circuit board (PCB)
- (6) readout copper strips

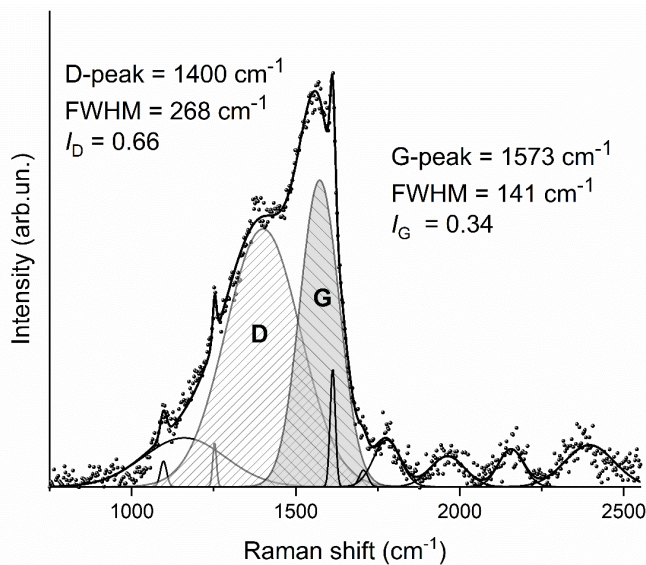
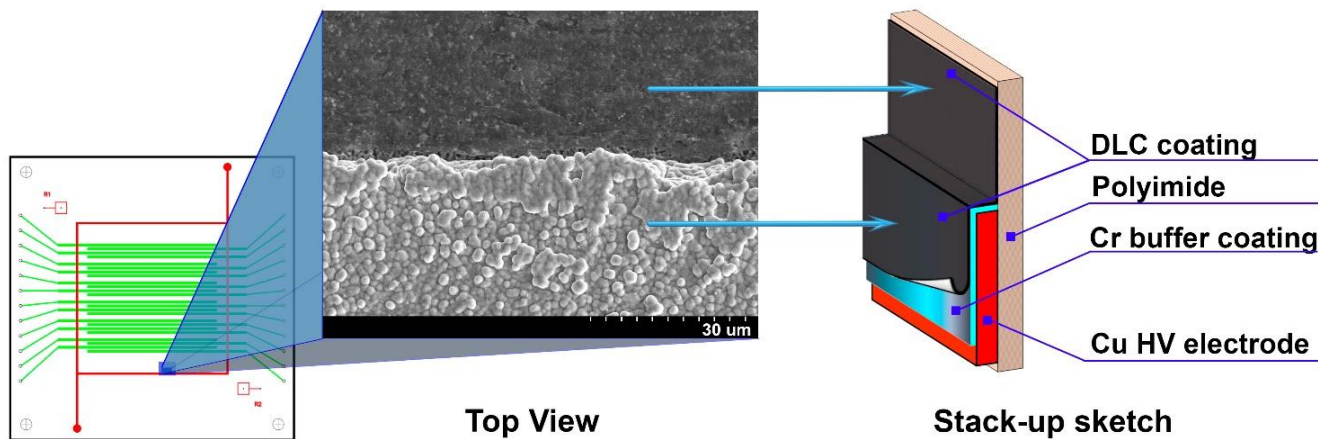


Prototype with active area 80mm x 80mm





# MicroMegas detector with the resistive DLC anode

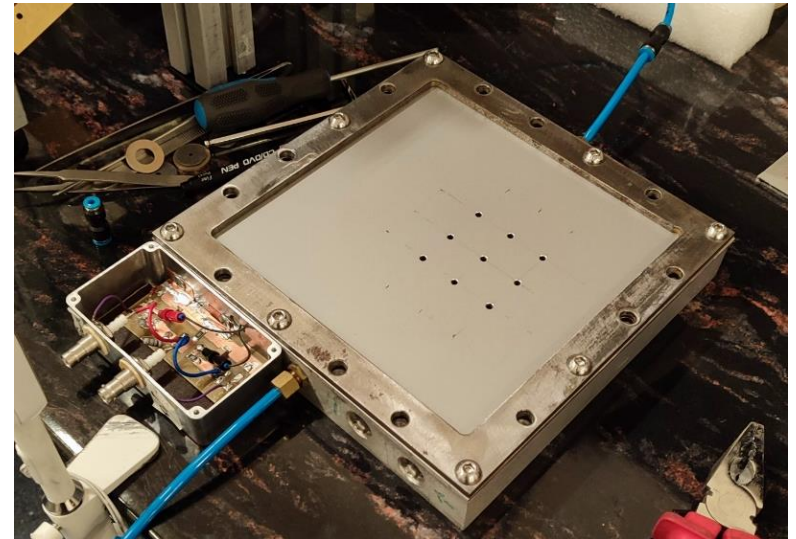
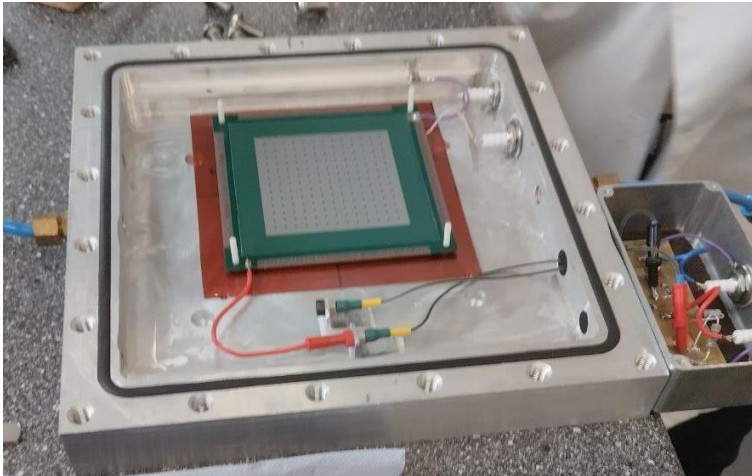
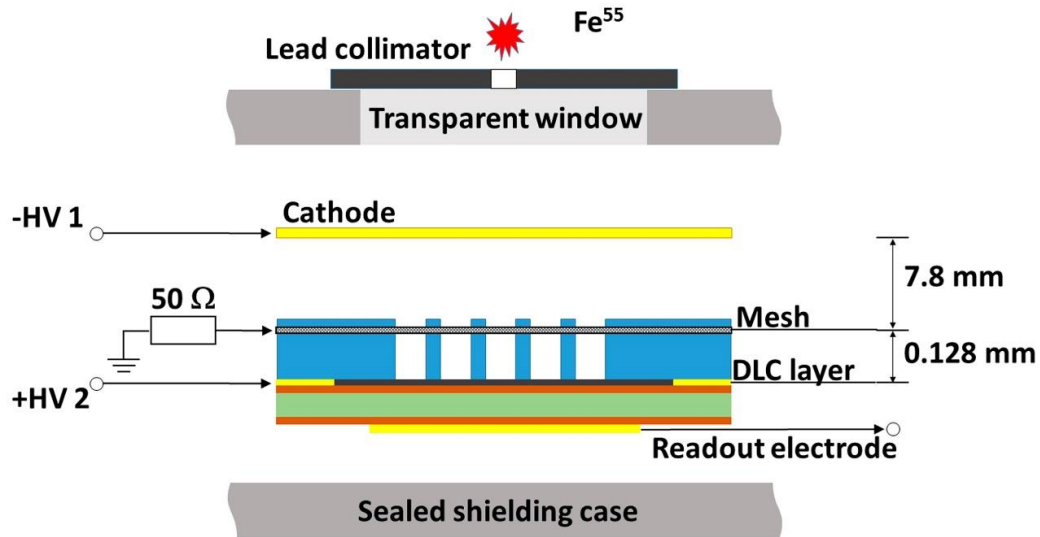


Raman spectrum of DLC layer reveals that **the content of sp<sup>3</sup>-hybridized carbon bonds close to 34 %**

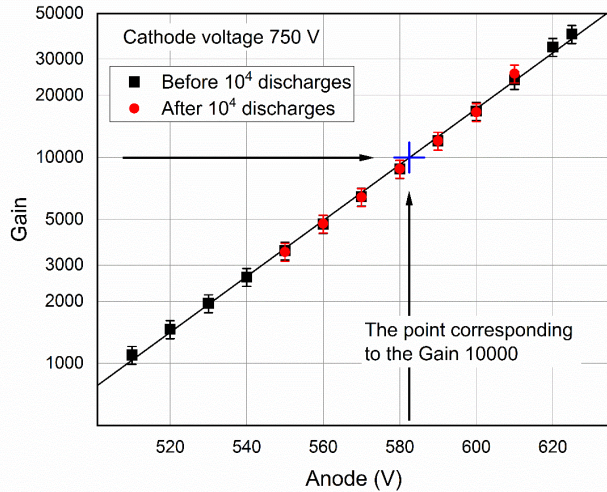
*G peak – sp<sup>3</sup> – diamond-like*  
*D peak – sp<sup>2</sup> – graphite-like*

# Test of MicroMegas detector with the resistive DLC anode

Test Setup:

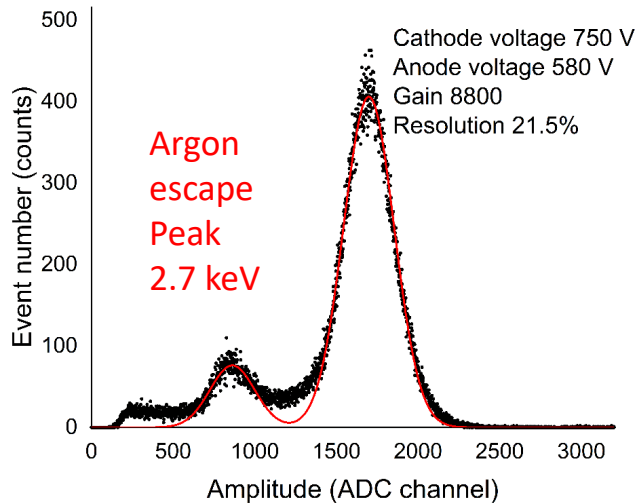


# Test of MicroMegas detector with the resistive DLC anode

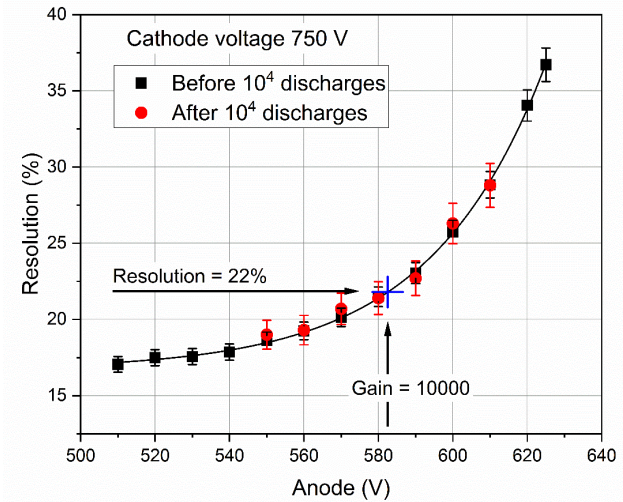


*The dependence of gas gain on anode voltage*

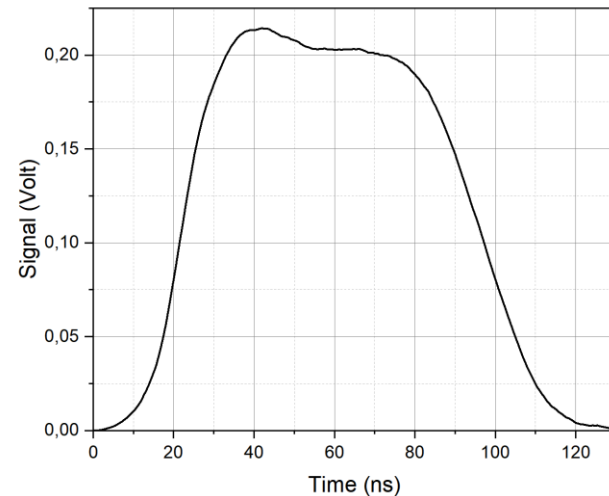
5.9 keV



Amplitude spectrum of the  $^{55}\text{Fe}$  radioactive source



*The dependence of energy resolution on anode voltage*

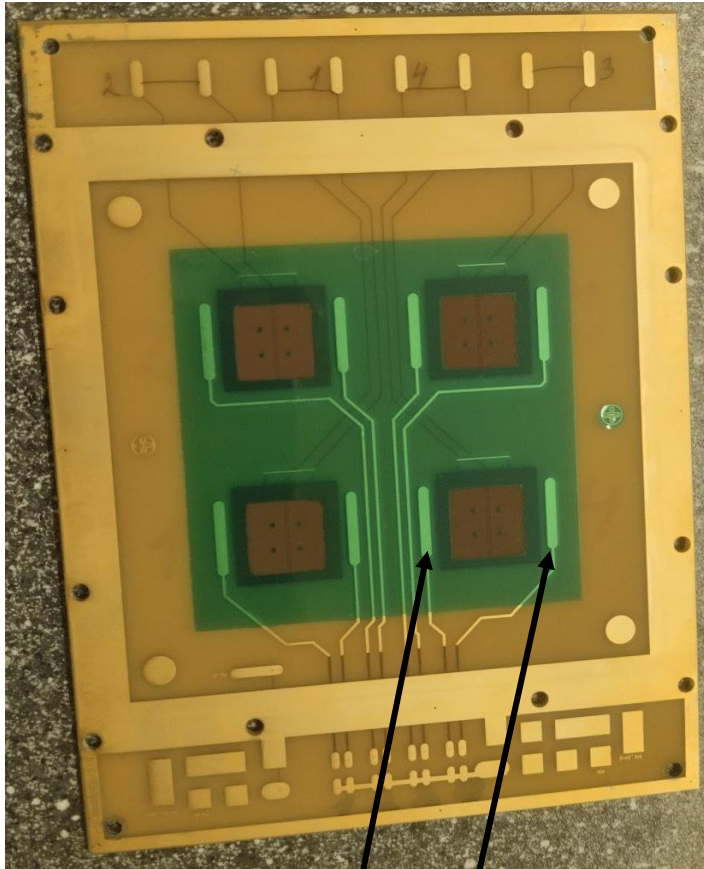


signal rise time 5 ns  
signal formation time 10 ns

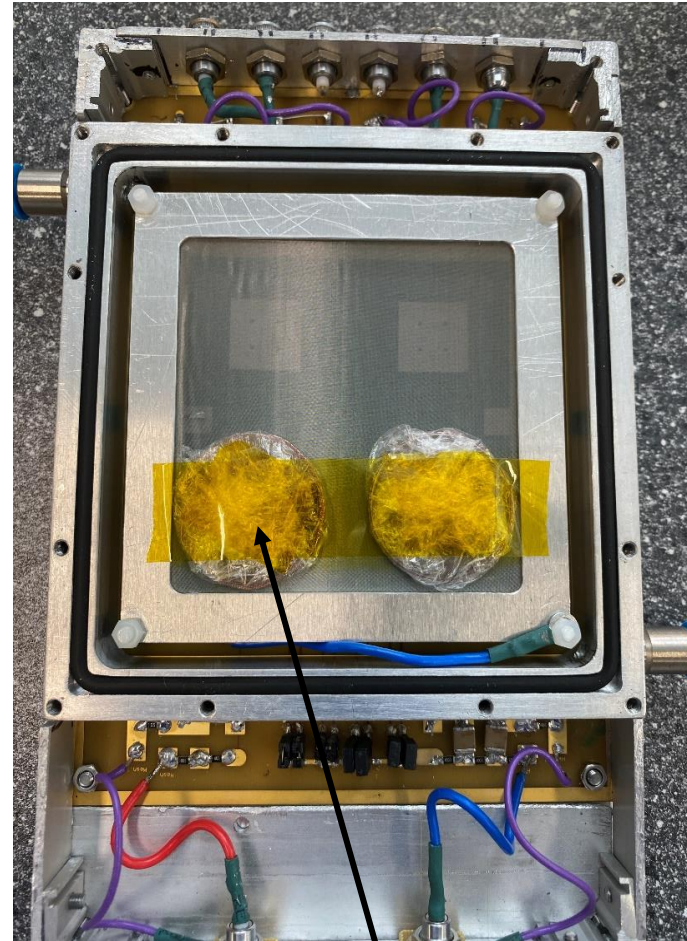


# Discharge Robustness of the DLC Anode

Special MicroMegas chamber with DLC anode. 4 active areas.



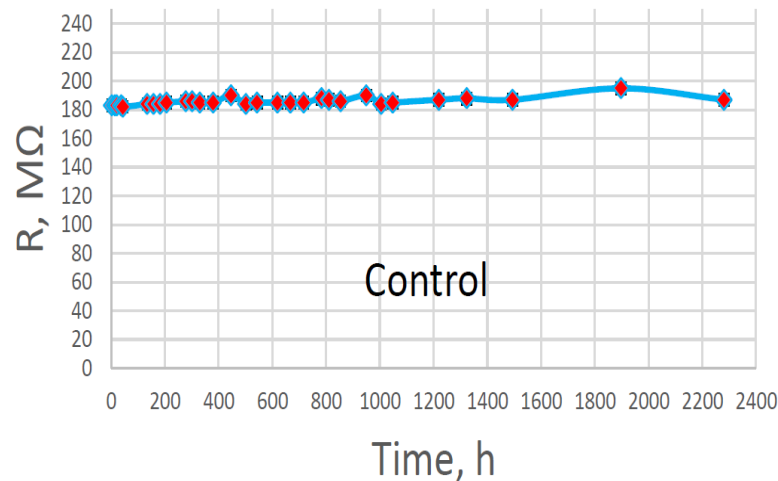
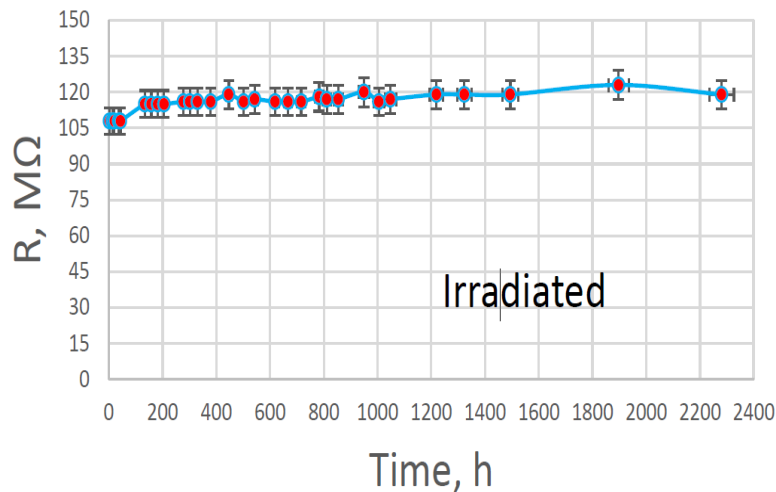
Contacts to apply HV and measure Resistivity



Alpha source to induce electrical discharges (Pu-238 and Pu-239)



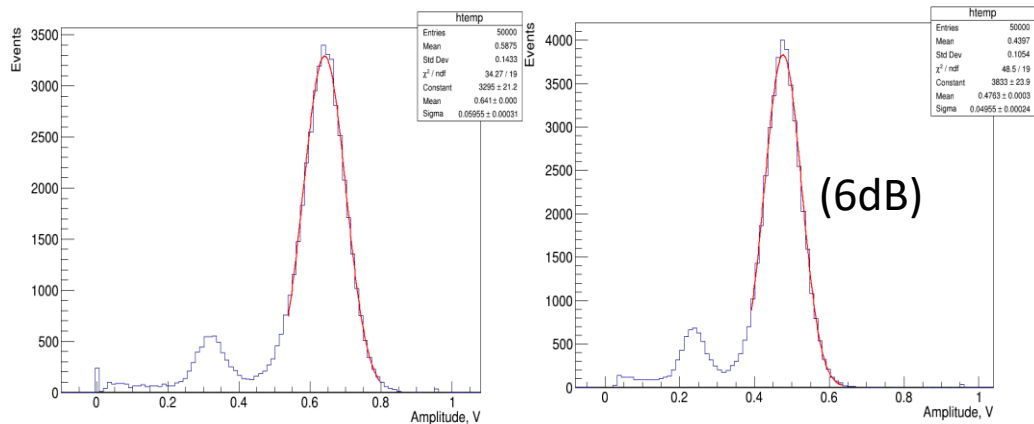
# Discharge Robustness of the DLC Anode



Resistivity Dependence of DLC layer on time of irradiation by alpha source

Total number of discharges  $9E8$   
during 2300 hours

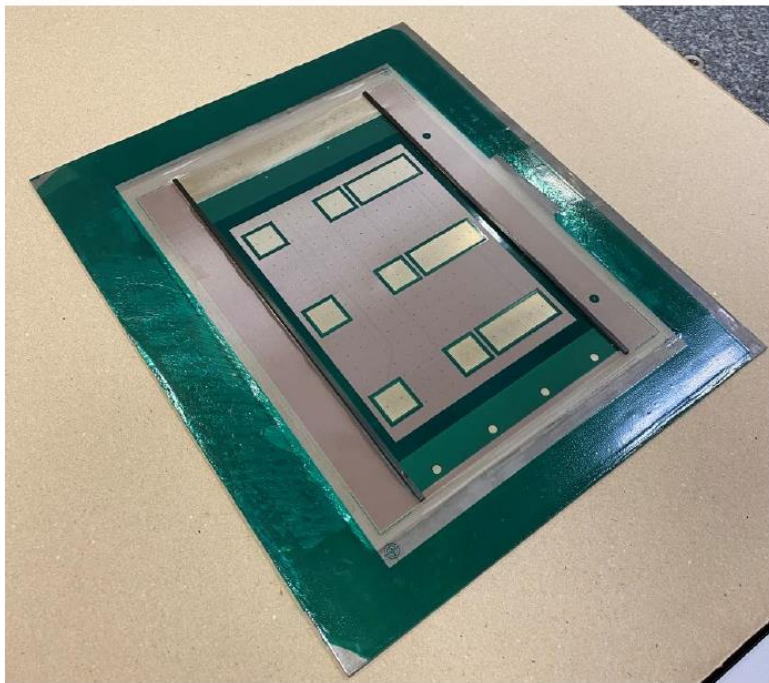
**No significant signs of  
degradation are observed**



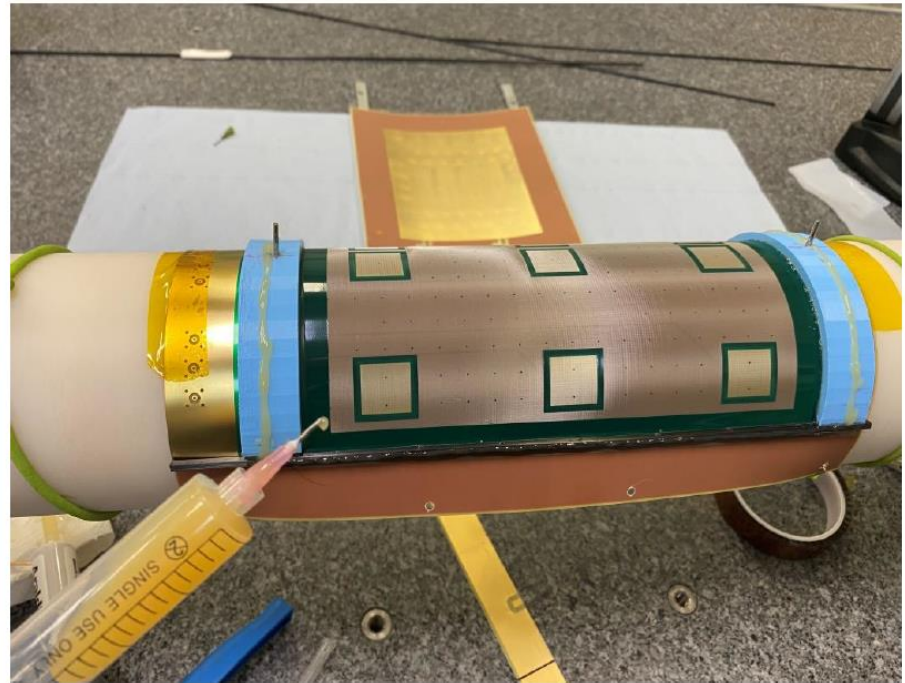
Control energy spectra of X-ray source Fe-55

# Первый прототип цилиндрической камеры

MM module (anode PCB + mesh)  
before bending



MM module bended on assembling  
table before cathode gluing



Signal electrodes shaped as 9 pad to check gain ( $\Leftrightarrow$  gap) uniformity after bending

2024

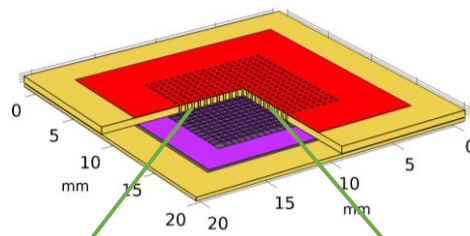
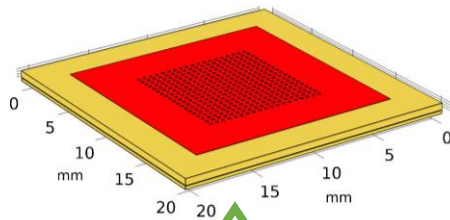
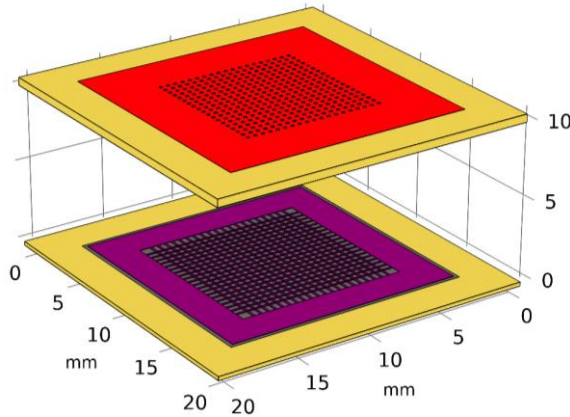
Д.В. Дедович "Центральный трекер для эксперимента SPD на основе детекторов Micromegas"

вторник 28 мая 2024 г., 11:00 → 13:00 Europe/Moscow

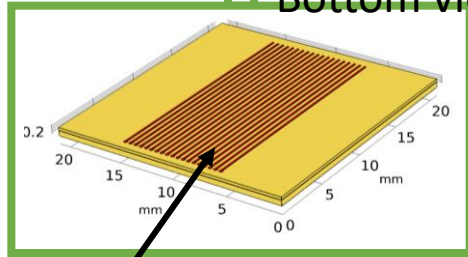
# Resistive Well Electron Multiplier (R-WEM) with DLC anode

The R-WEM detector is composed of two parts.

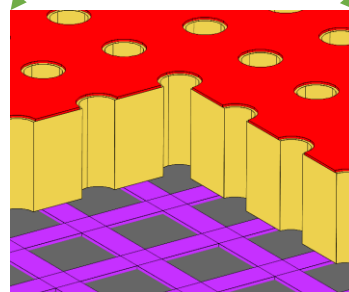
1. 500  $\mu\text{m}$  thick FR4 board metallized on one side with drilled holes of 200  $\mu\text{m}$  in diameter and 500  $\mu\text{m}$  in pitch.
2. FR4 board contains copper HV-grid metallization and DLC layer on top side and readout electrodes at the bottom side



Bottom view

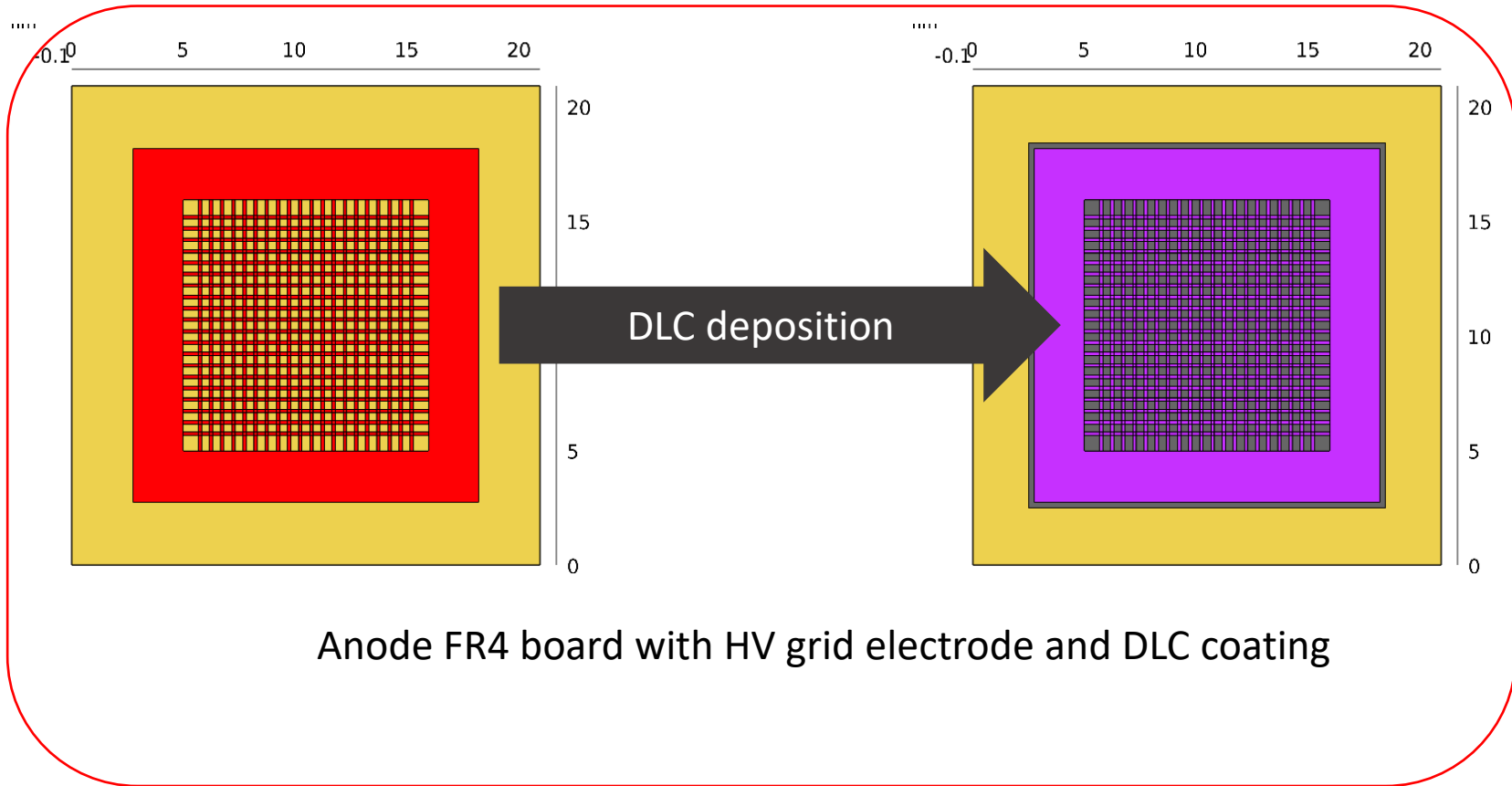


Read-Out Strips



Two boards were combined together into a single multilayer board in such a way that the grid conductors are located between the holes of the perforated board and the DLC coating inside the grid cell is below the holes.

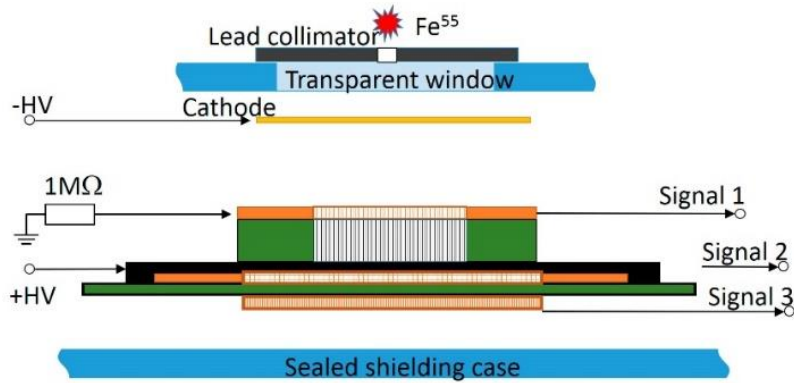
# Resistive Well Electron Multiplier (R-WEM) with DLC anode



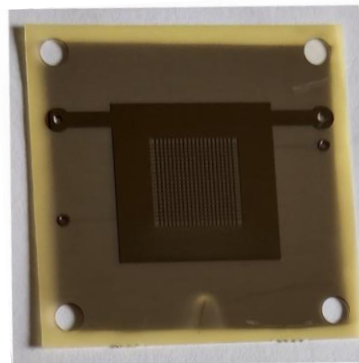
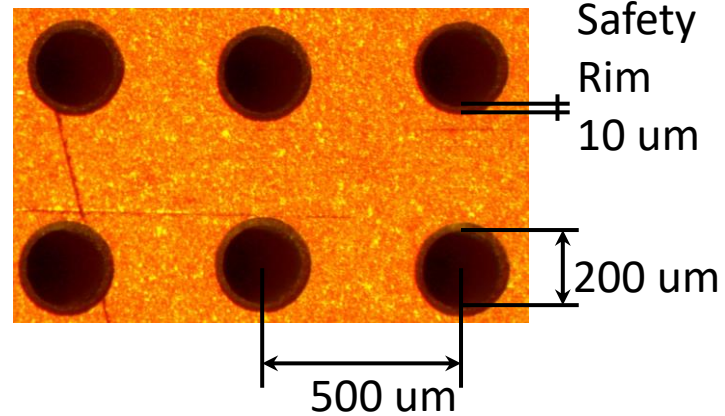
- The anode HV-grid is used to improve avalanche electron evacuation from DLC (ultra high rate capability)
- The resistive DLC layer with a sheet resistance of 30 M $\Omega$ /square is supposed to limit the electrical current of discharges produced by highly ionizing particles



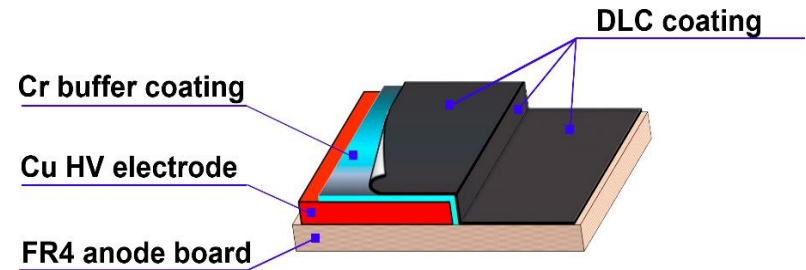
# Resistive Well Electron Multiplier (R-WEM) with DLC anode



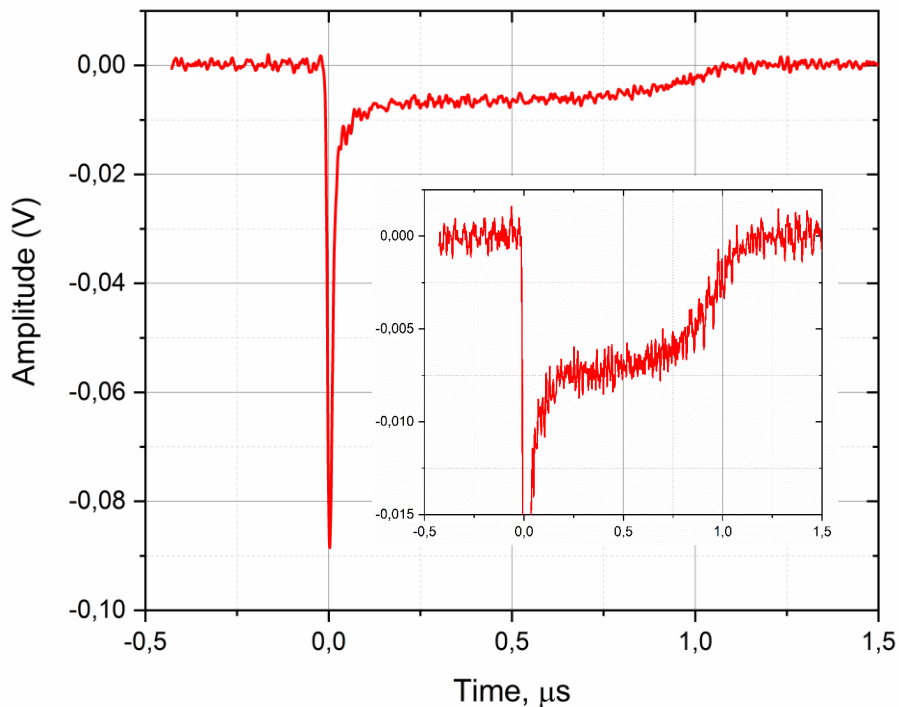
## Perforated FR4



**Anode board with HV-grid and DLC coating**



# Resistive Well Electron Multiplier (R-WEM) with DLC anode



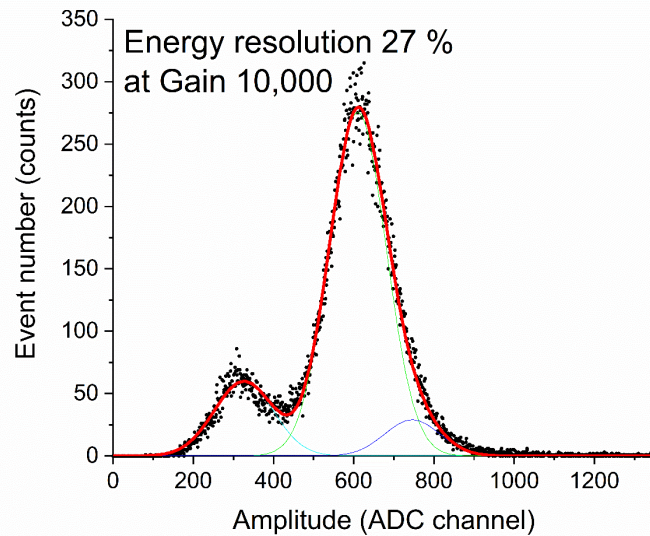
20mV/fC

signal rise time 5 ns

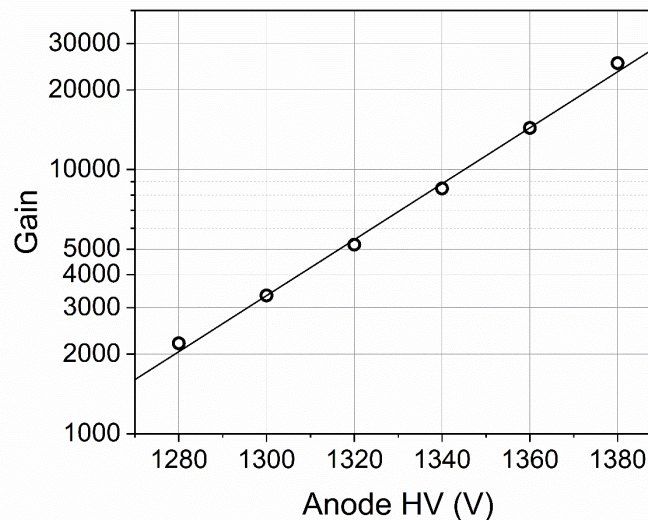
signal formation time 10 ns

Electron component 20 ns

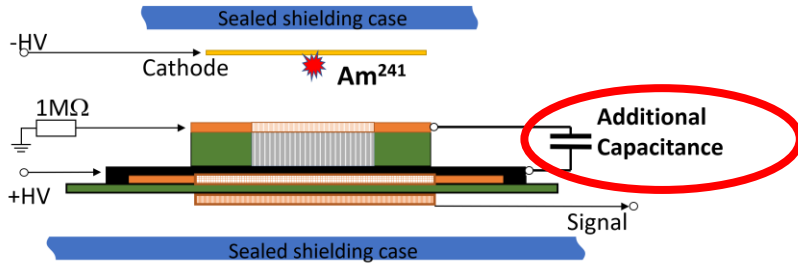
Ion component 1 μs



Amplitude spectrum of the <sup>55</sup>Fe radioactive source



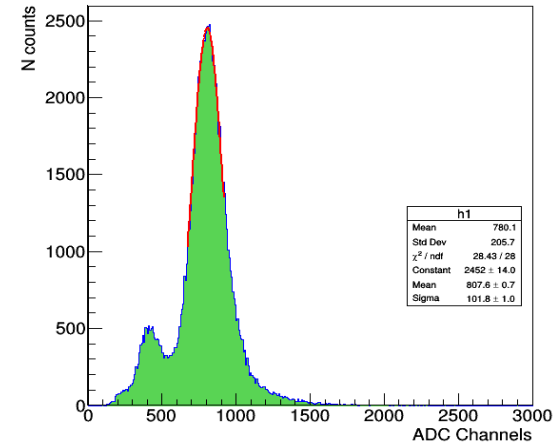
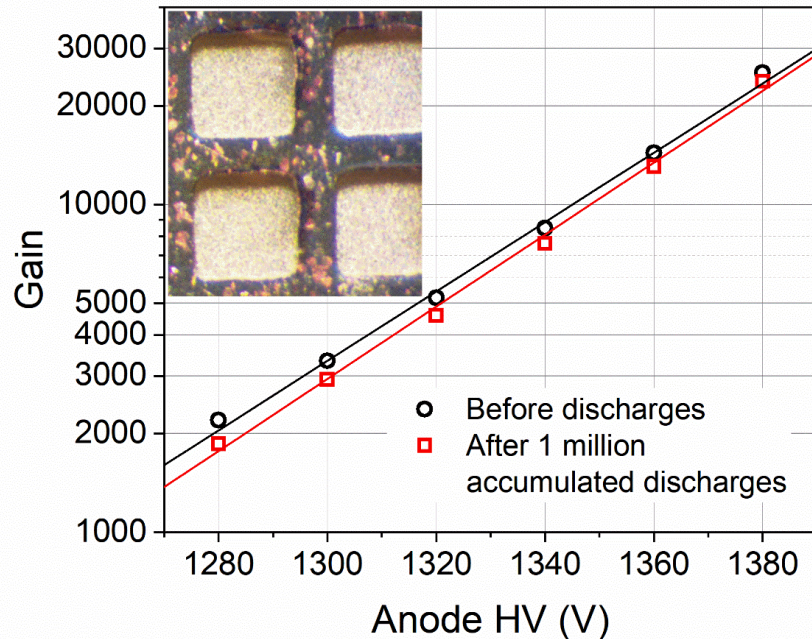
# Effect of Multiple Discharges on Accumulated Damage in R-WEM with DLC Anode



To simulate a large area R-WEM we used an Additional Capacitance, in parallel with R-WEM anode and top electrode

The discharge events initiated by an  $Am^{241}$  alpha source.  
The circular alpha source 3 mm in diameter, activity of **33 Bq**

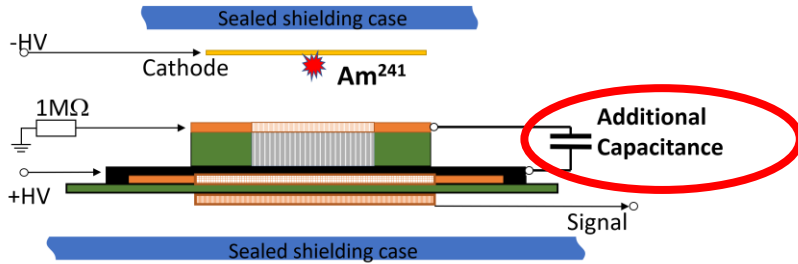
Active Area	Capacitance with the frame	Energy of discharges	Number of discharges
<b>10 x 10 mm<sup>2</sup></b>	<b>34 pF</b>	<b>29 μJ</b>	<b>1,000,000</b>
60 x 60 mm <sup>2</sup>	360 pF	0.3 mJ	100,000
100 x 100 mm <sup>2</sup>	1 nF	0.9 mJ	100,000



No damage is observed after **1,000,000 discharges** for active area **10 x 10 mm<sup>2</sup>**



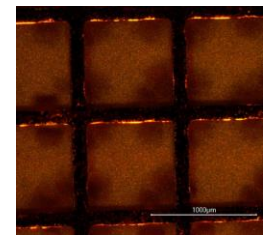
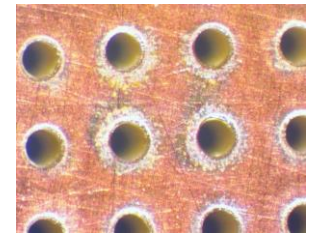
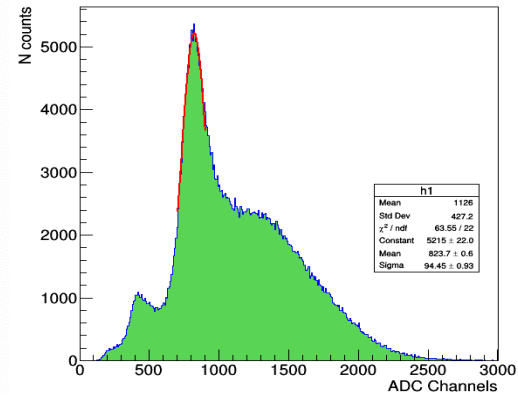
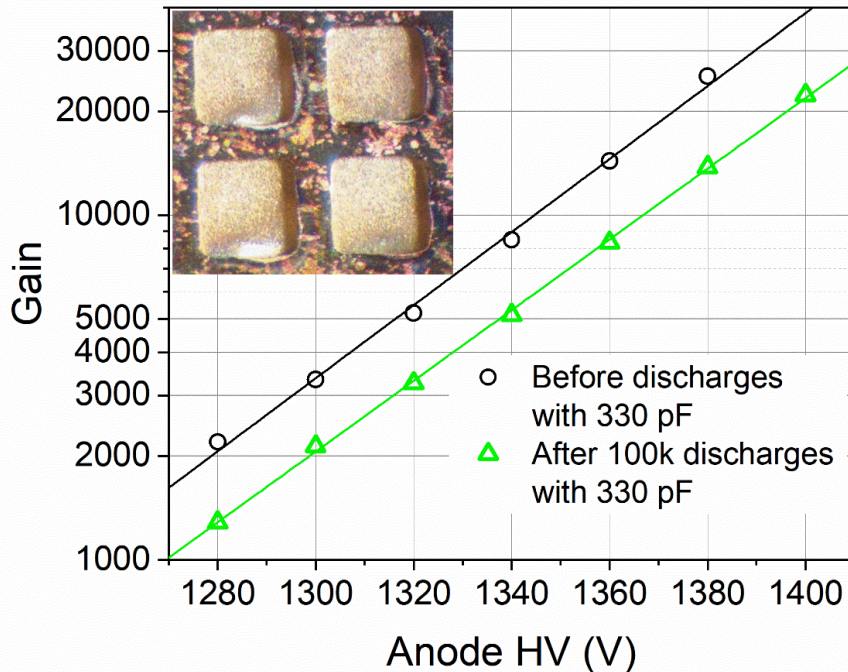
# Effect of Multiple Discharges on Accumulated Damage in R-WEM with DLC Anode



The discharge events initiated by an  $\text{Am}^{241}$  alpha source.  
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Active Area	Capacitance with the frame	Energy of discharges	Number of discharges
10 x 10 mm <sup>2</sup>	34 pF	29 μJ	1,000,000
60 x 60 mm <sup>2</sup>	360 pF	0.3 mJ	100,000
100 x 100 mm <sup>2</sup>	1 nF	0.9 mJ	100,000

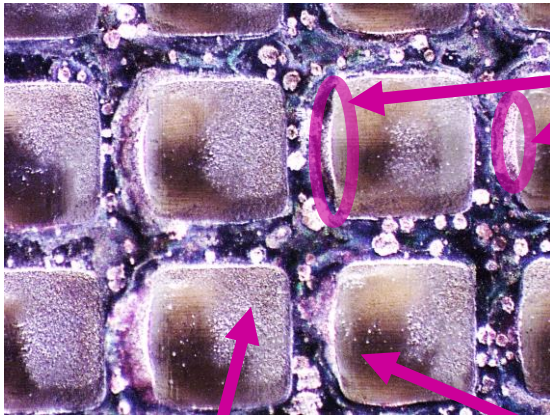
To simulate a large area R-WEM we used an Additional Capacitance, in parallel with R-WEM anode and top electrode



After **100,000 discharges** for active area **60 x 60 mm<sup>2</sup>** a slight visible damage was observed



# Effect of Multiple Discharges on Accumulated Damage in R-WEM with DLC Anode

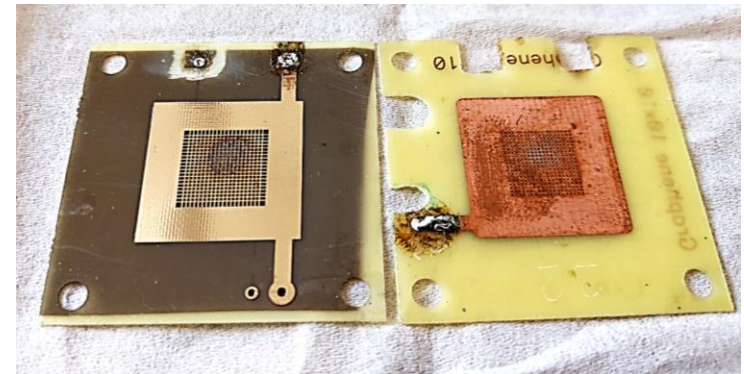
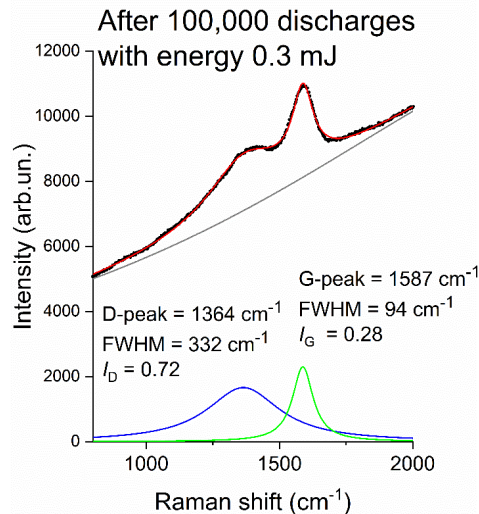
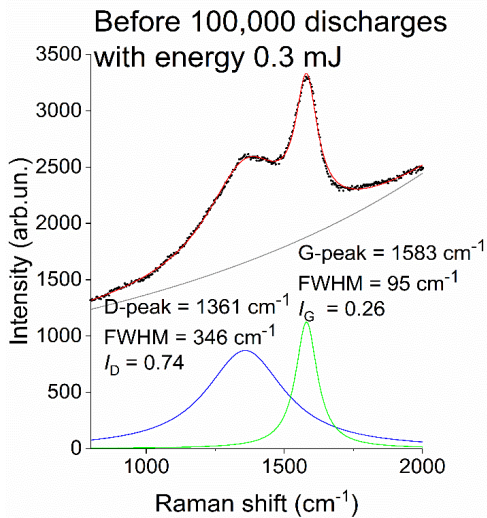


*Damaged HV-grid*

*Raman confirm the presence of DLC layer with lower thickness*

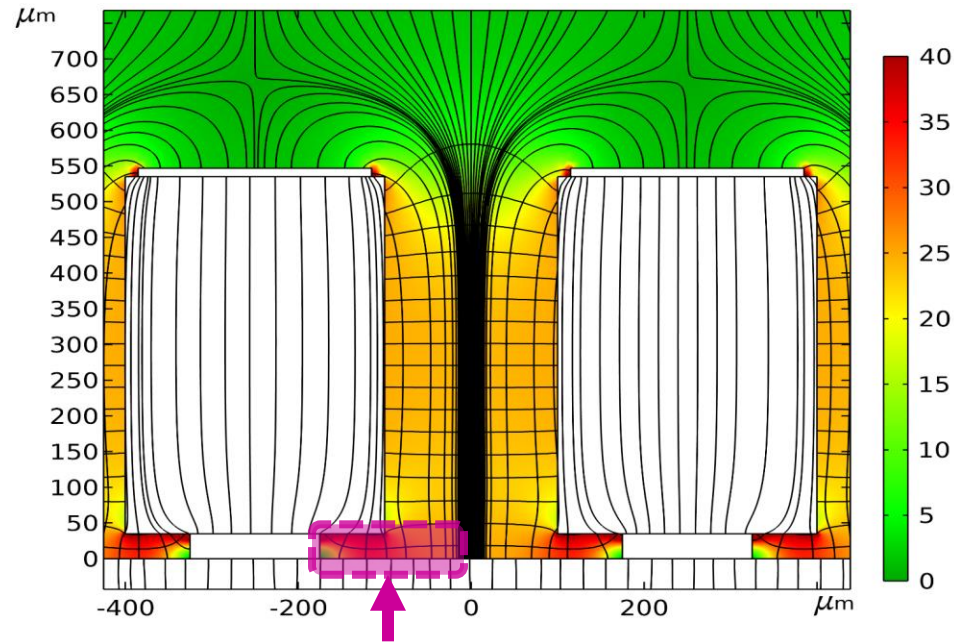
The discharge events initiated by an  $\text{Am}^{241}$  alpha source. The circular alpha source 3 mm in diameter, activity of 33 Bq

Active Area	Capacitance with the frame	Energy of discharges	Number of discharges
10 x 10 mm <sup>2</sup>	34 pF	29 $\mu\text{J}$	1,000,000
60 x 60 mm <sup>2</sup>	360 pF	0.3 mJ	100,000
100 x 100 mm <sup>2</sup>	1 nF	0.9 mJ	100,000



The further increase of the discharge energy by adding a capacitance up to  $C = 1 \text{ nF}$  (active area 100 x 100 mm<sup>2</sup>) resulted in a significant damage to the DLC layer and the perforated FR4 board after 100,000 discharges. Both plates of the detector were significantly damaged

# Effect of Multiple Discharges on Accumulated Damage in R-WEM with DLC Anode



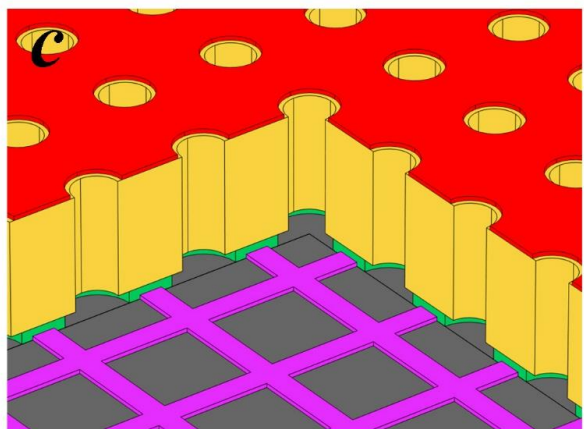
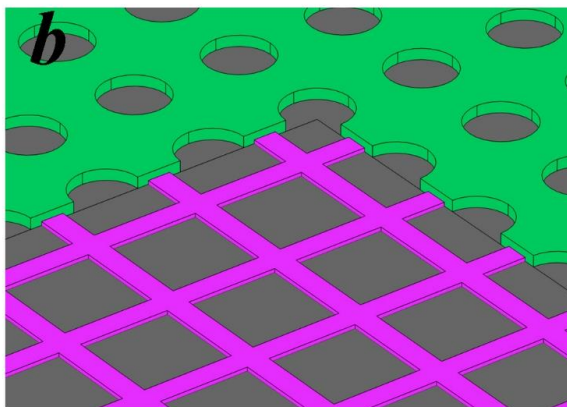
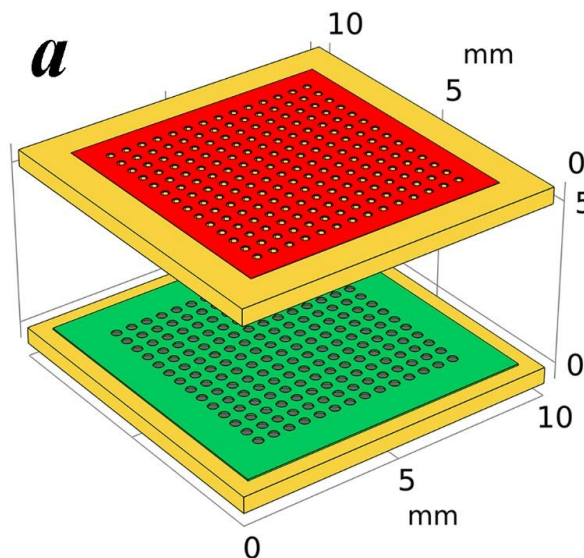
*Discharge channel through the gas gap*






- The HV-grid has a thickness of  $35\ \mu\text{m}$  and this results in a gap between the Perforated FR4 board and the Anode board.
- The electric field strength in this gap has a local maximum relative to the center of the multiplication hole.
- When the discharge occurs, the discharge channel does not terminate on the resistive layer directly under the multiplication hole but instead goes above the resistive layer through the gas in the gap and terminates into the metal of the charge evacuation grid.

**The damage of DLC layer itself is small, because the discharge current pass through the gas gap**

# R-WEM with DLC Anode and isolated HV-grid

*The Insulation of HV-grid avoid discharges from top electrode to HV-grid and allows to make R-WEM detectors with large active areas*



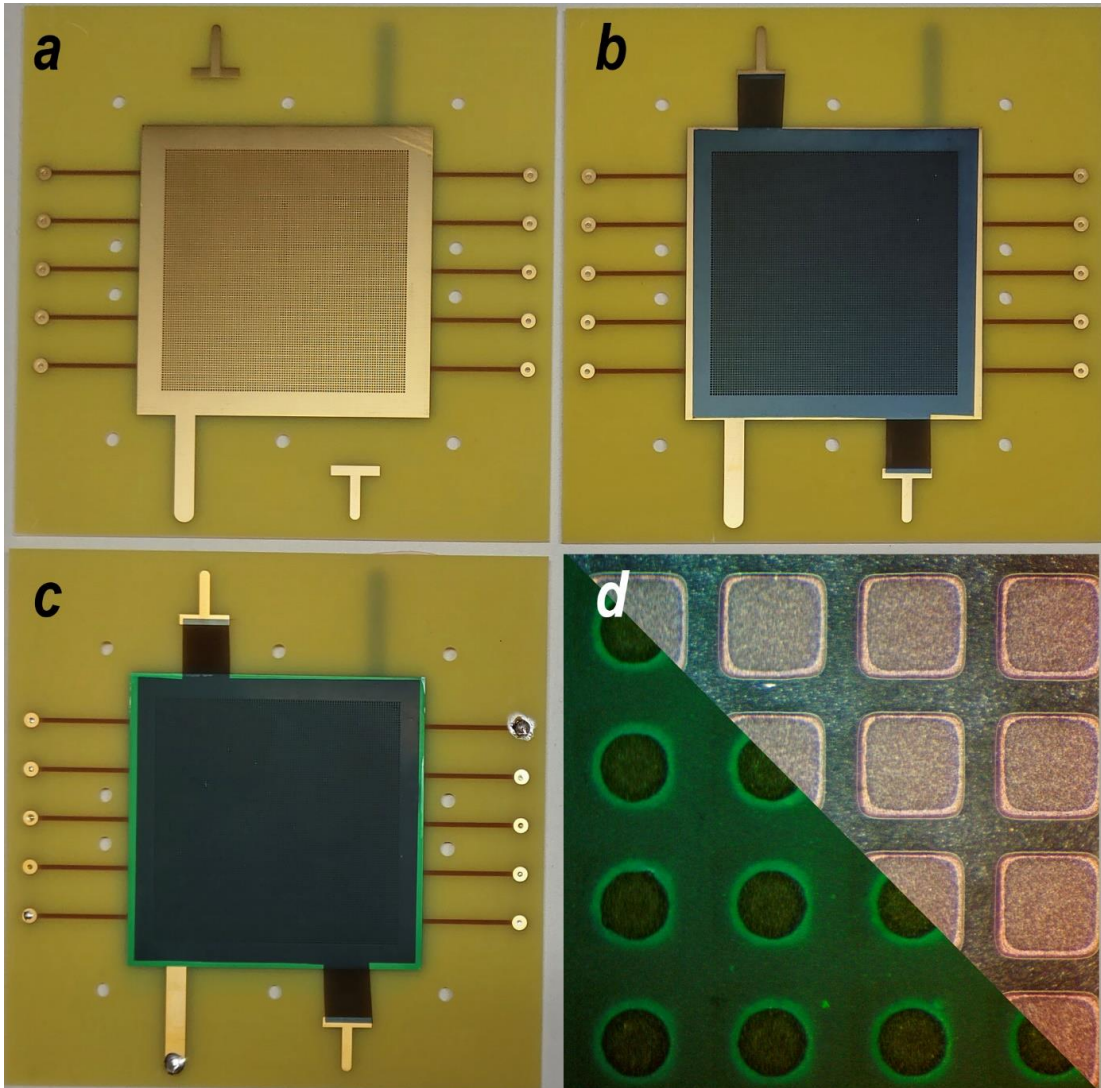
-  - FR4 boards
-  - Copper electrode
-  - HV-grid coated with DLC
-  - DLC coating
-  - Insulating microstructure

- a. Sketch of the WEM detector consisting of two boards*
- b. Enlarged sketch of the insulating microstructure on the resistive DLC anode with a high voltage grid alone*
- c. Combined with perforated FR4 board*



# R-WEM with DLC Anode and isolated HV-grid

*The Insulation of HV-grid avoid discharges from top electrode to HV-grid and allows to make R-WEM detectors with large active areas*



A photographic image of

**(a)** the anode FR4 board with high voltage grid

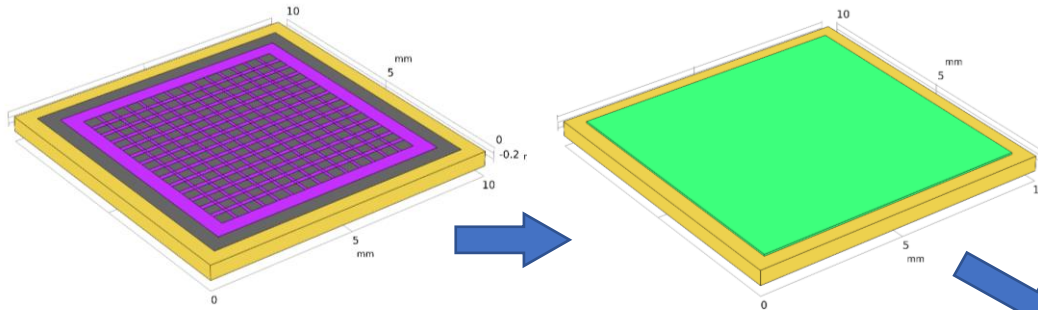
**(b, d)** the anode FR4 board with high voltage grid coated with DLC

**(c, d)** insulating structure.



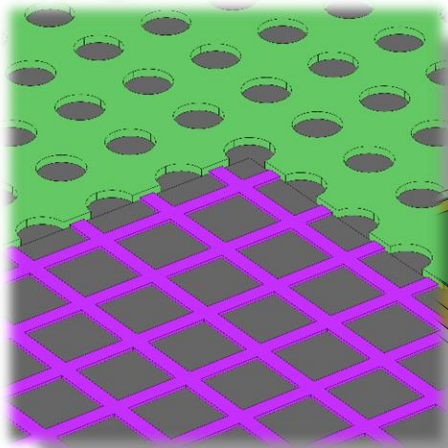
# R-WEM with DLC Anode and isolated HV-grid

To isolate HV-grid electrode we used liquid photoresistive solder mask

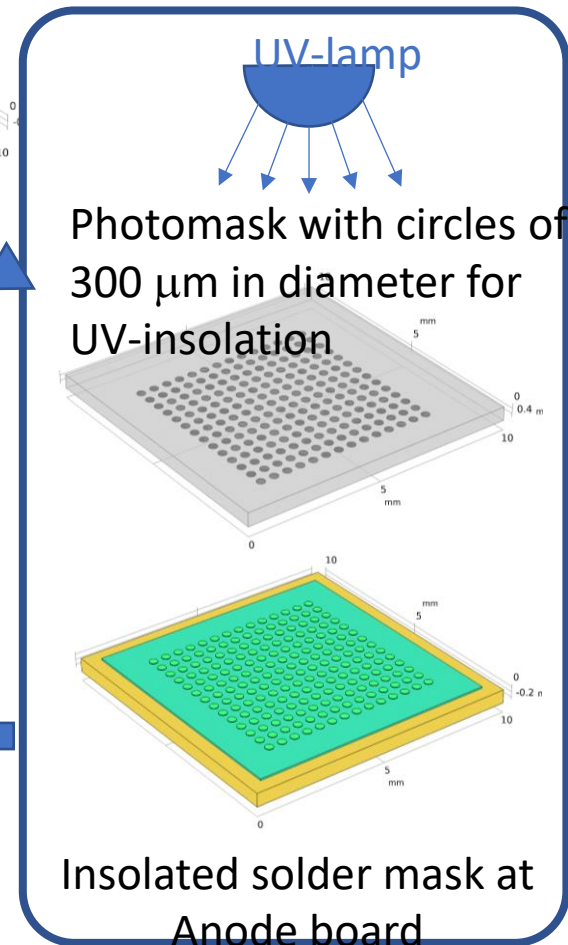


Anode FR4 board with HV-grid and **DLC coating**

Covering with solder mask layer (50  $\mu\text{m}$  thickness) using screen-printing



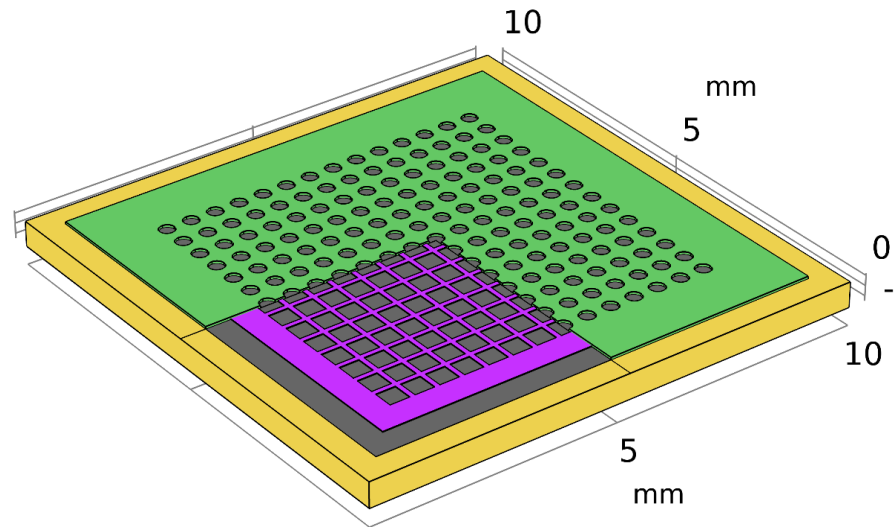
Anode FR4 board with isolated HV-grid and DLC coating



Photomask with circles of 300  $\mu\text{m}$  in diameter for UV-insolation

Insolated solder mask at Anode board

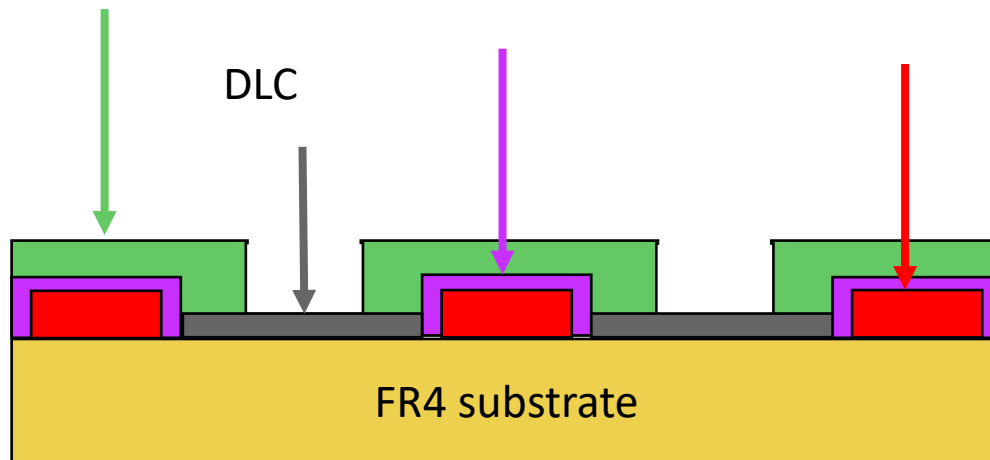
# R-WEM with DLC Anode and isolated HV-grid



Copper HV-g  
covered with  
DLC

Copper HV-grid

Isolator

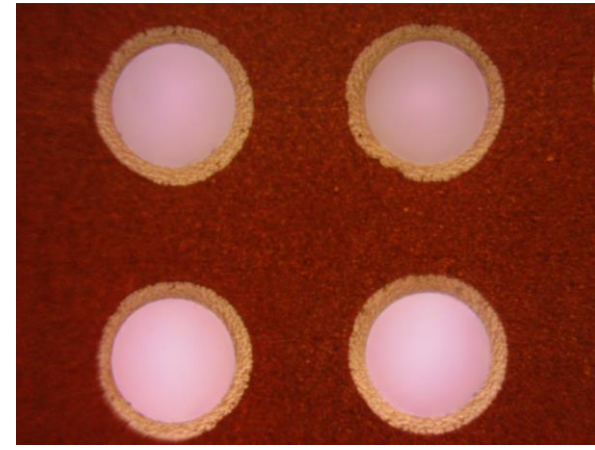
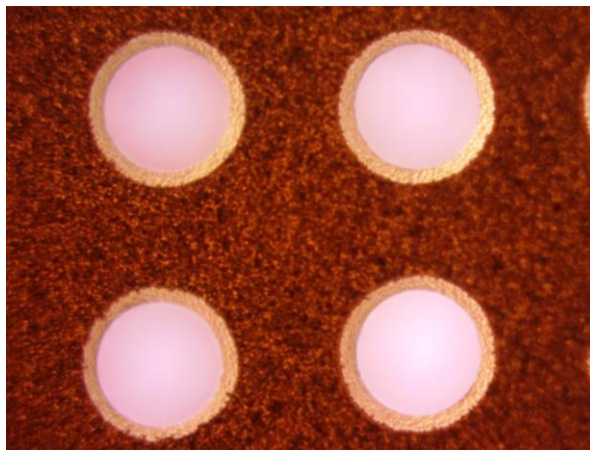
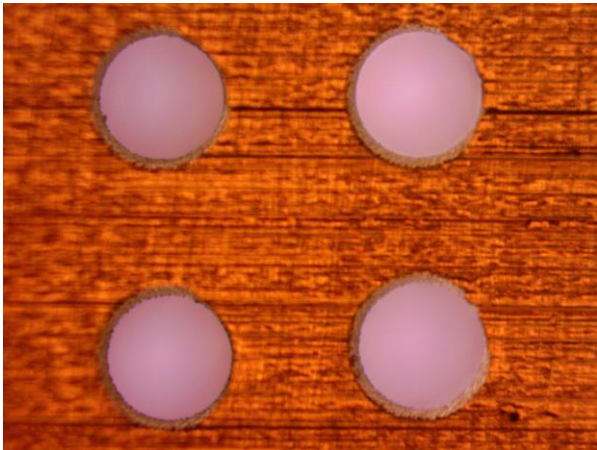
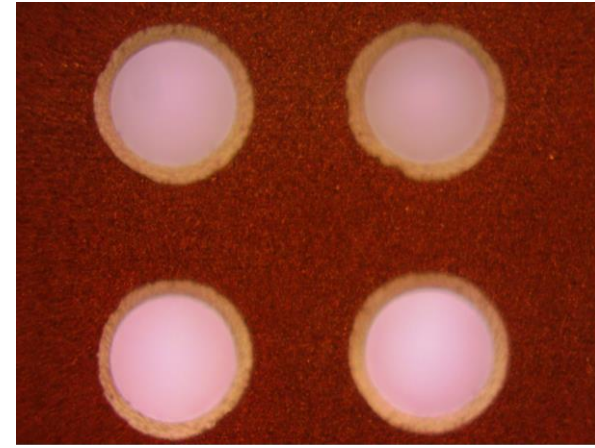
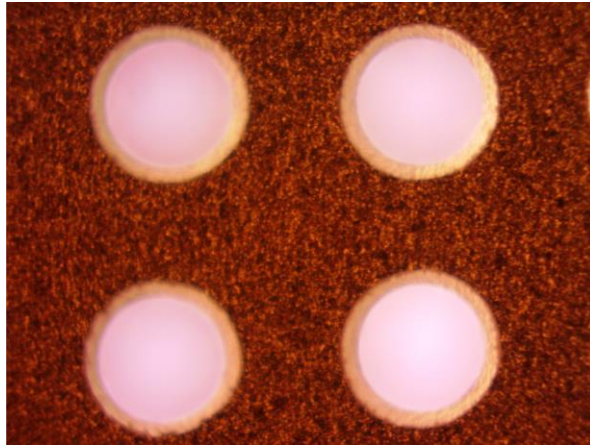
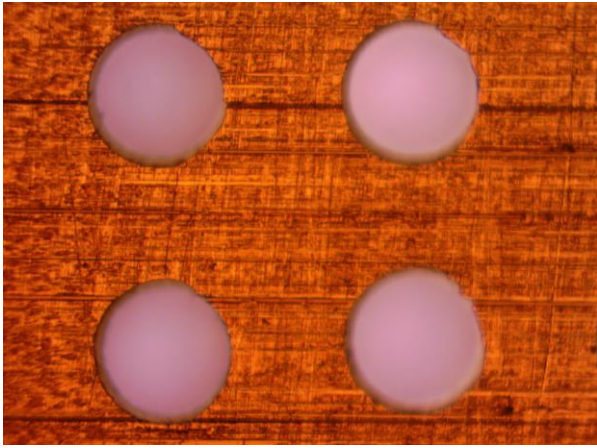


DLC

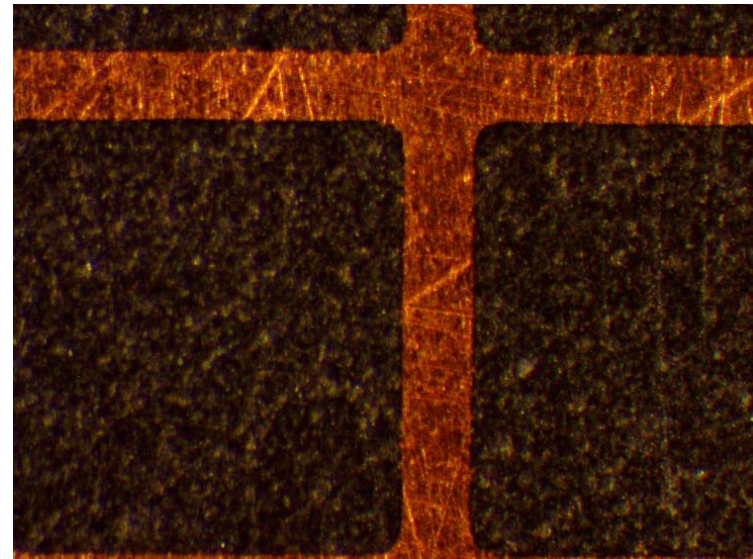
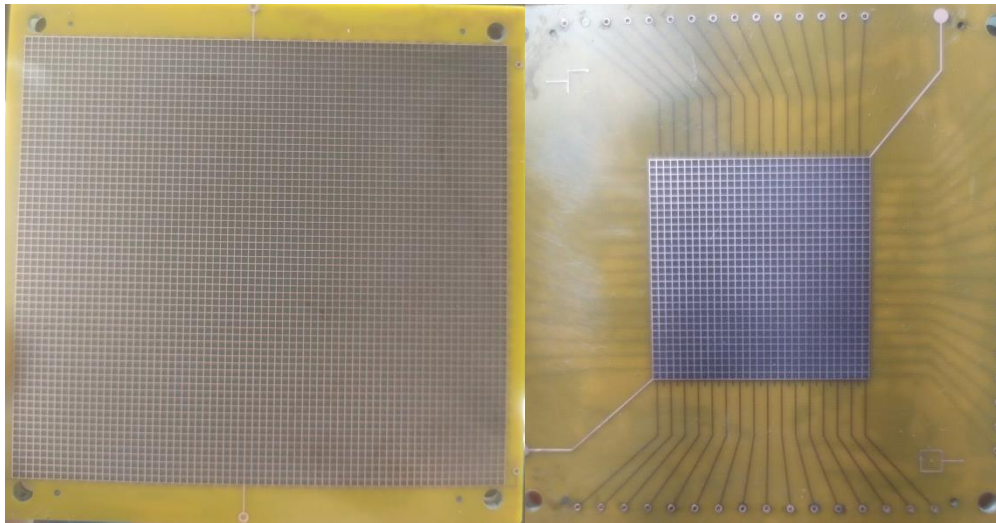
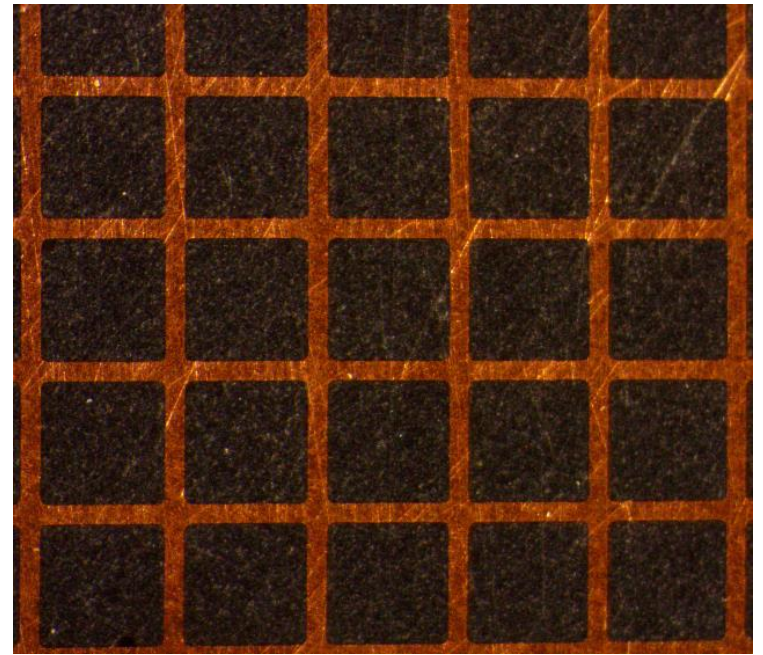
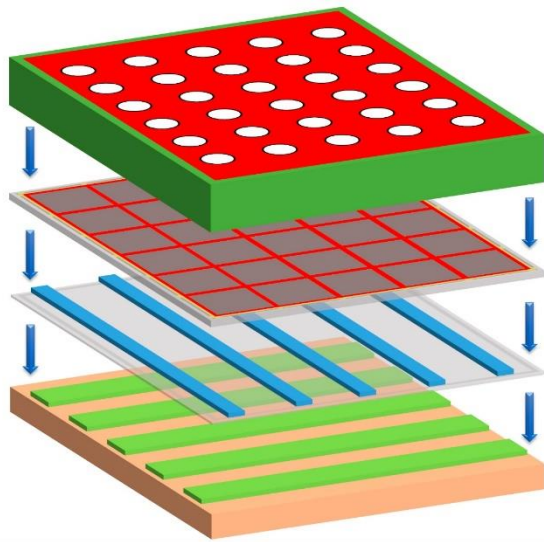
FR4 substrate

# Resistive Well Electron Multiplier (R-WEM) with DLC anode

500  $\mu\text{m}$  thick FR4 board metallized on one side with drilled holes of 200  $\mu\text{m}$  in diameter and 500  $\mu\text{m}$  in pitch

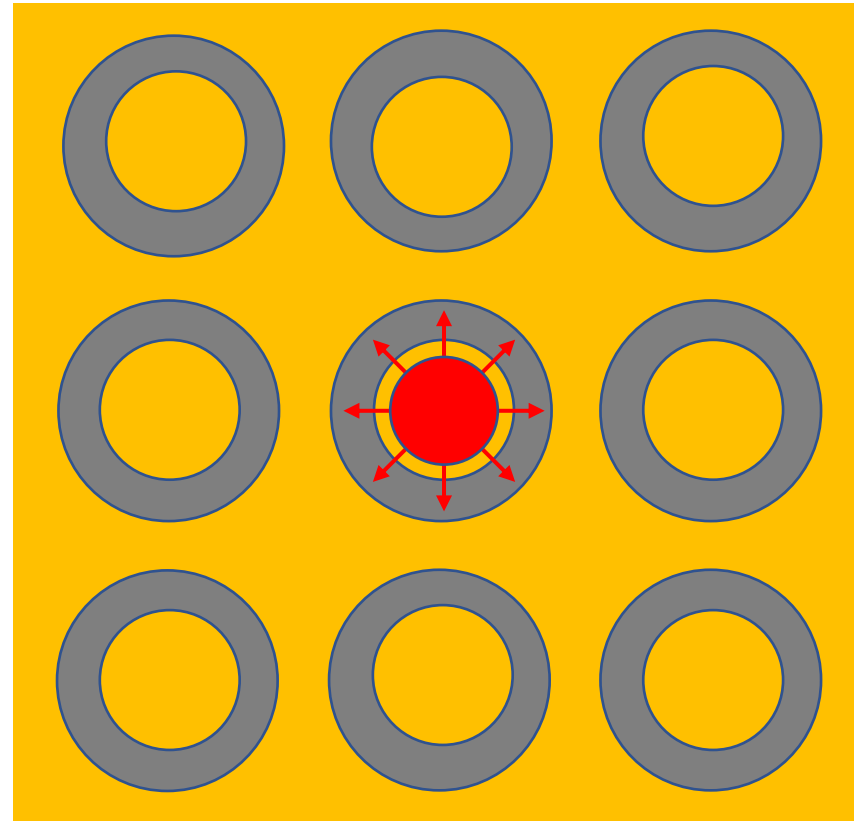
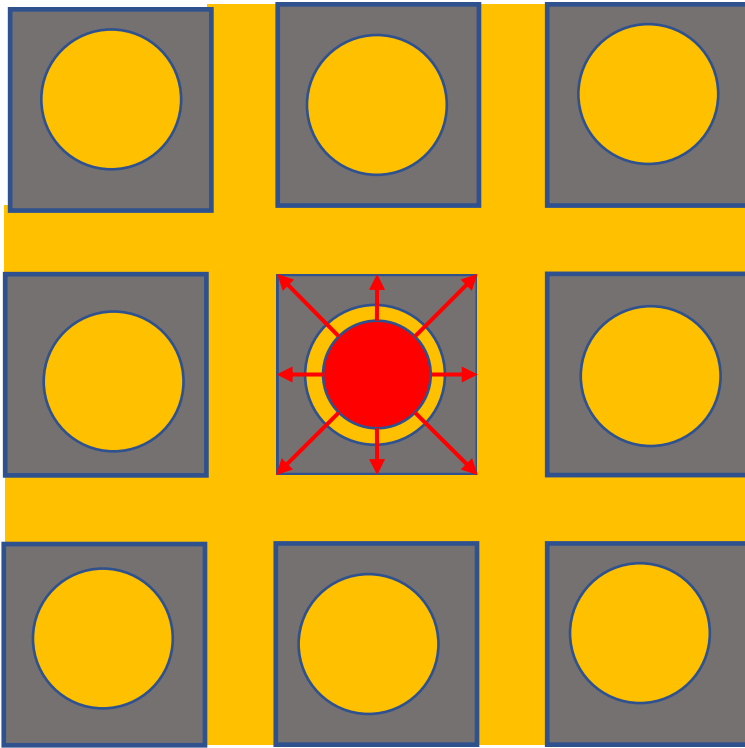


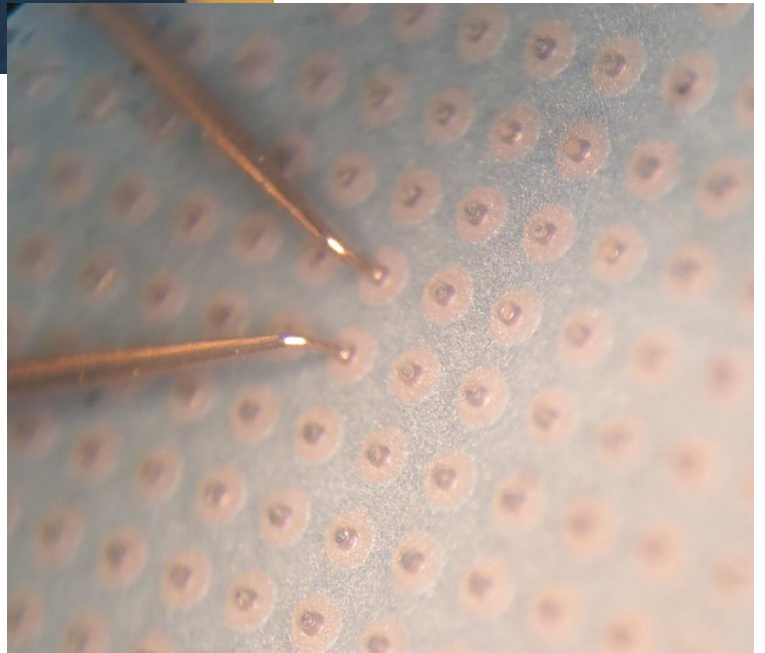
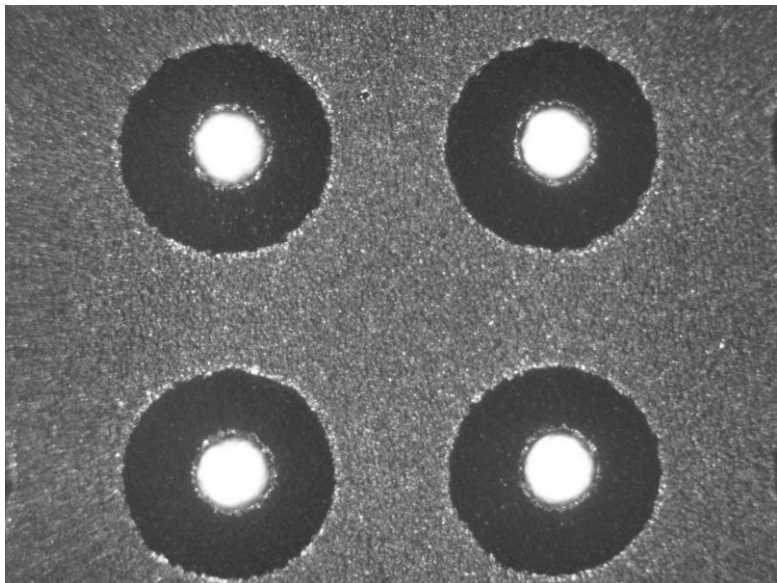
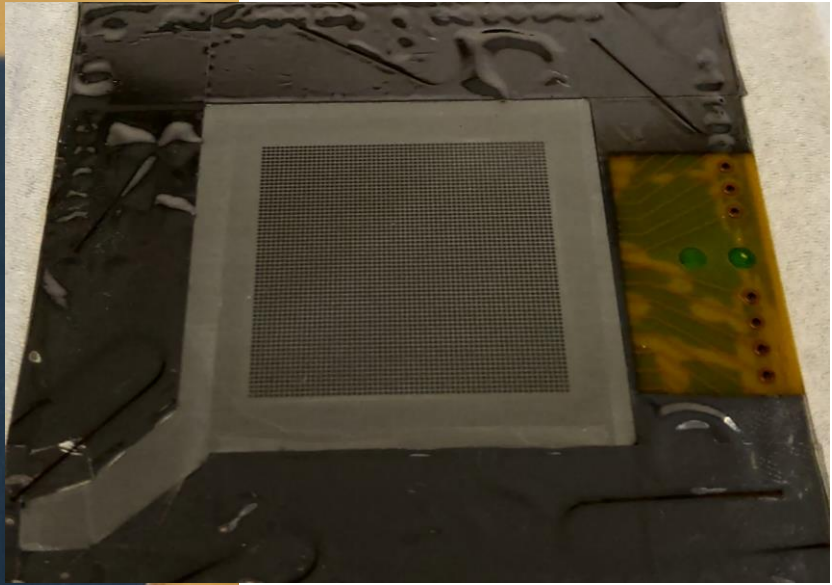
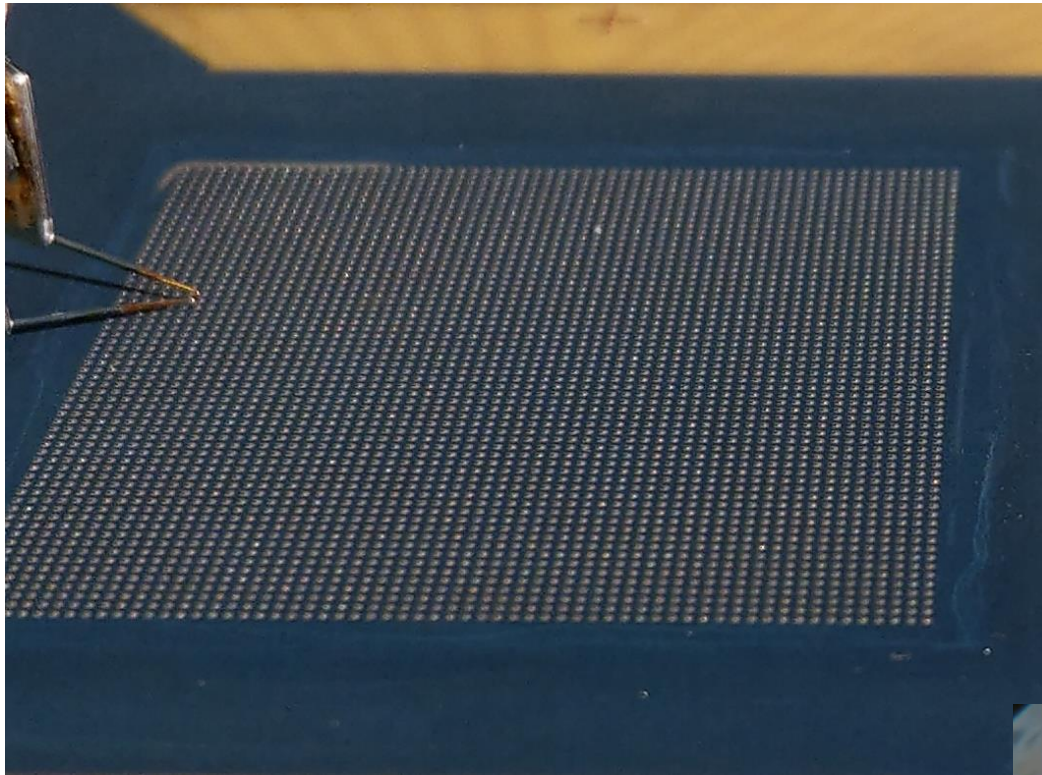




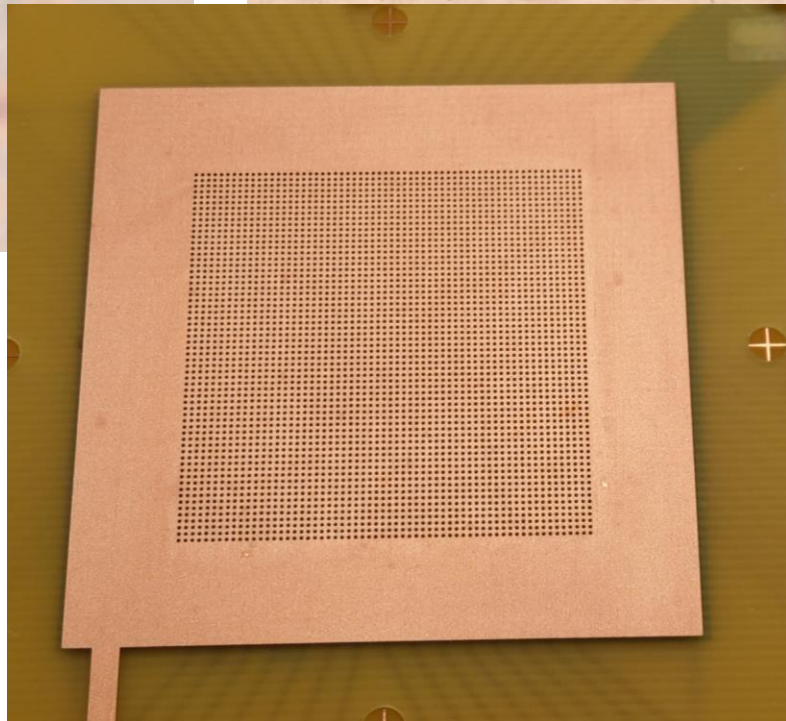
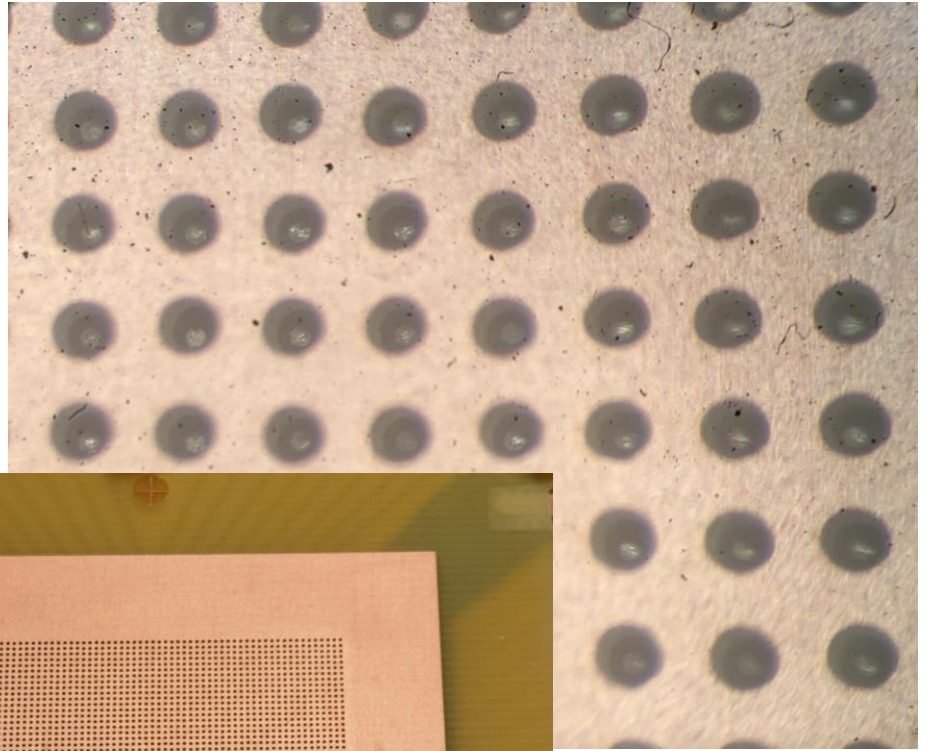
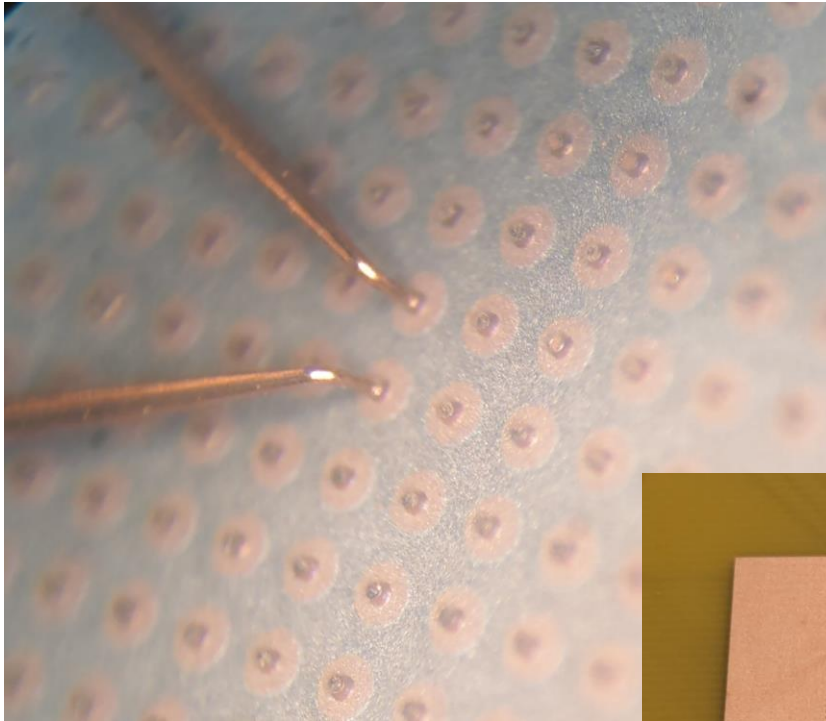


# Анод с медным дном, связанный с сеткой, на которую подается напряжение, через слой DLC

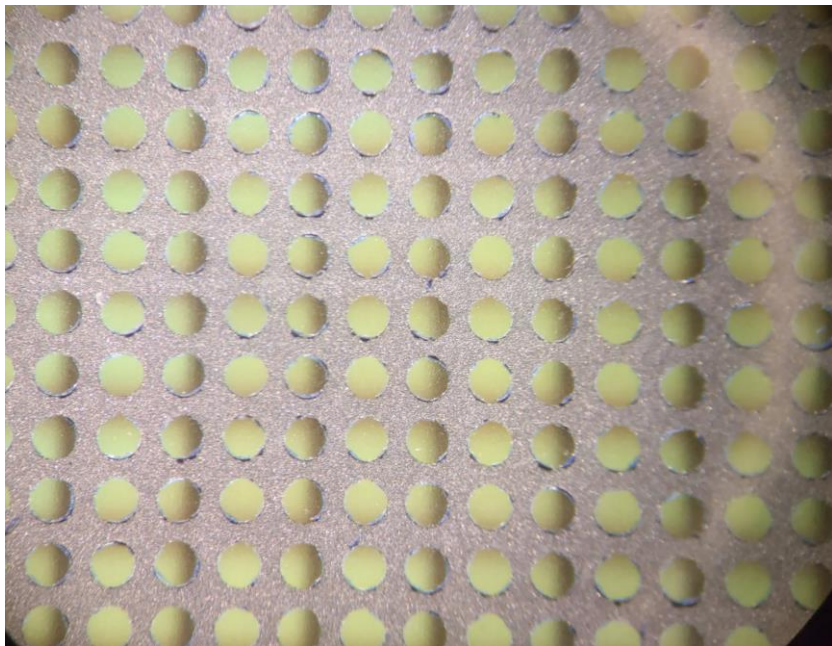
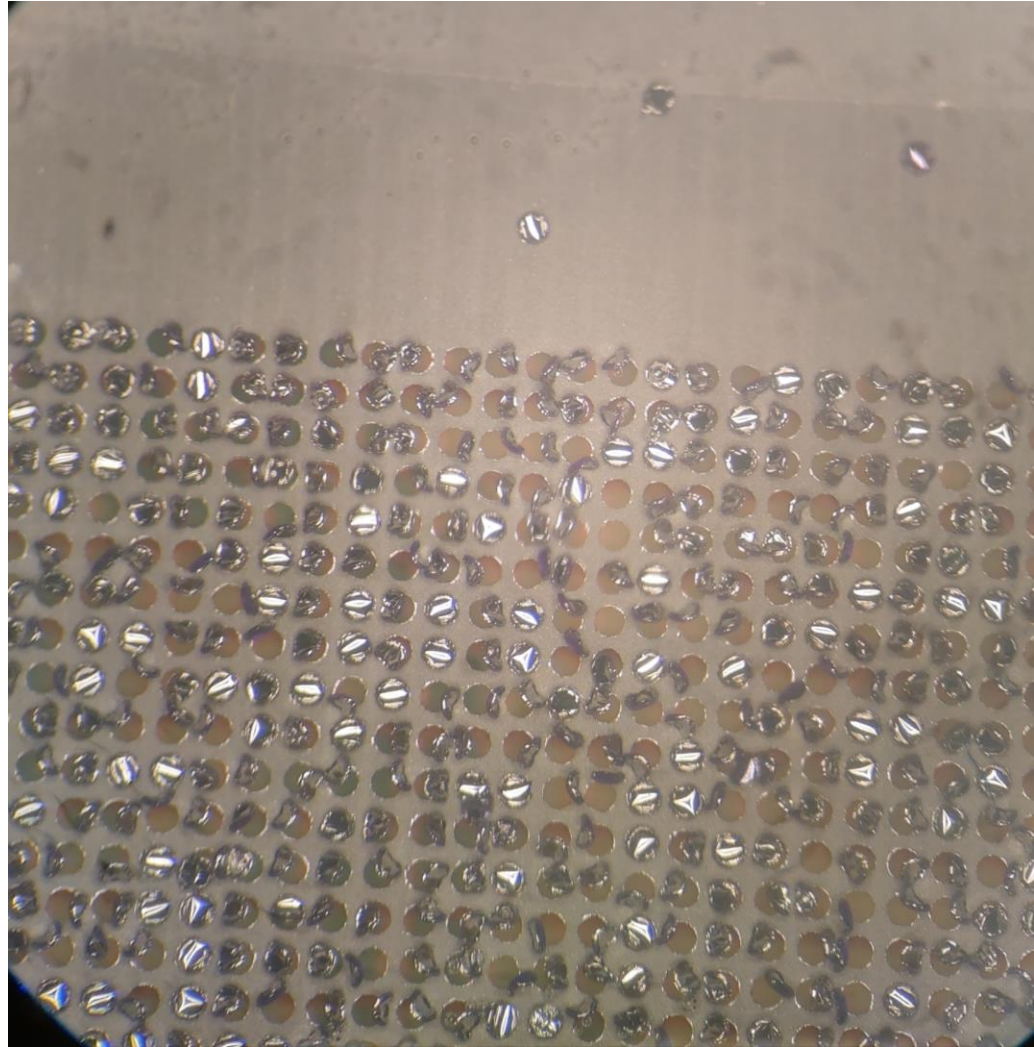
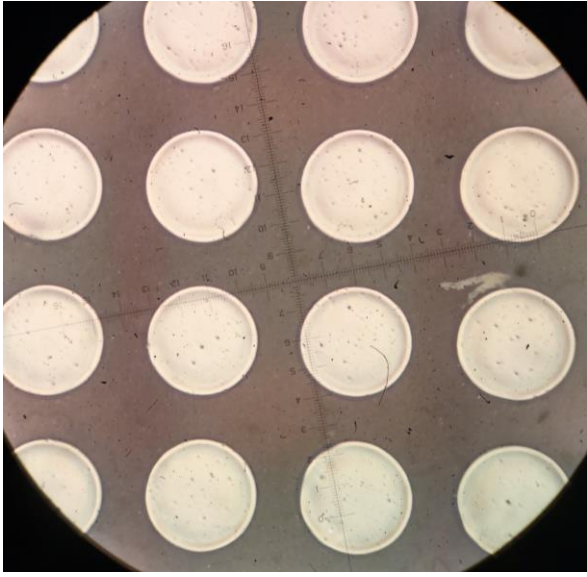




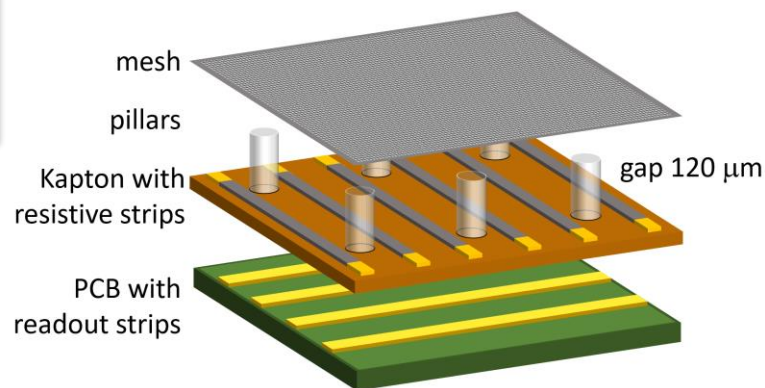
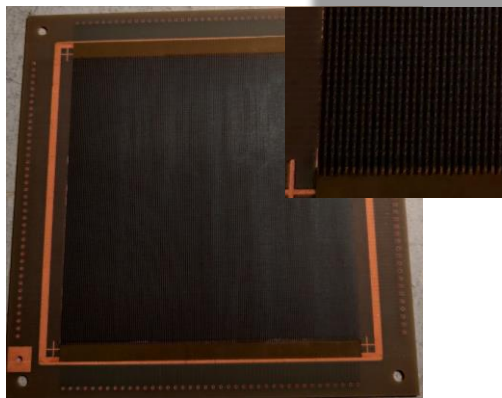




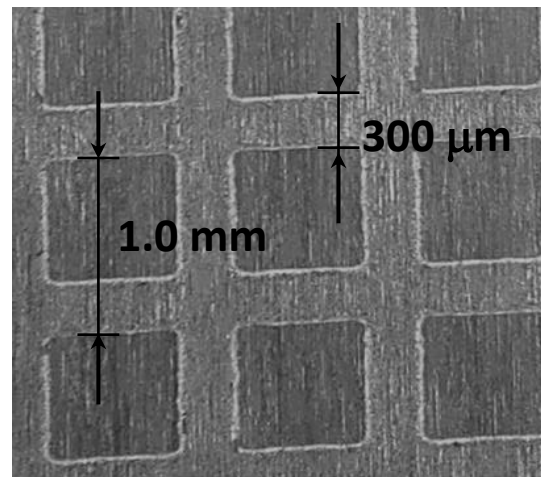
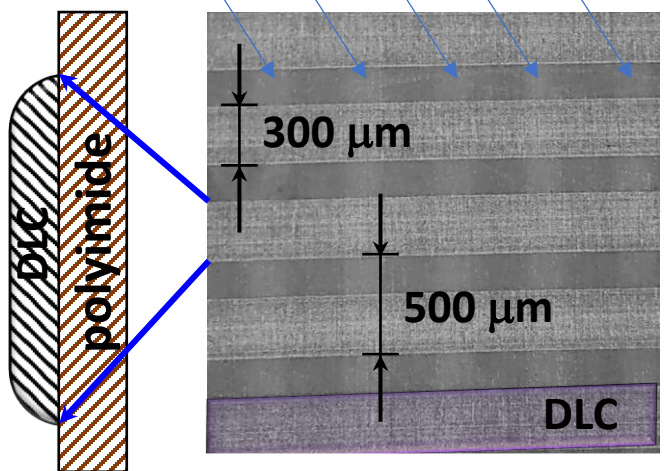




# Structured DLC anode for MicroMegas



*Readout strips under polyimide*



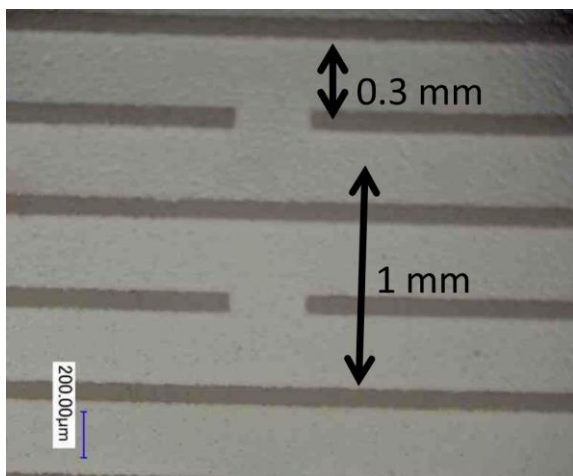
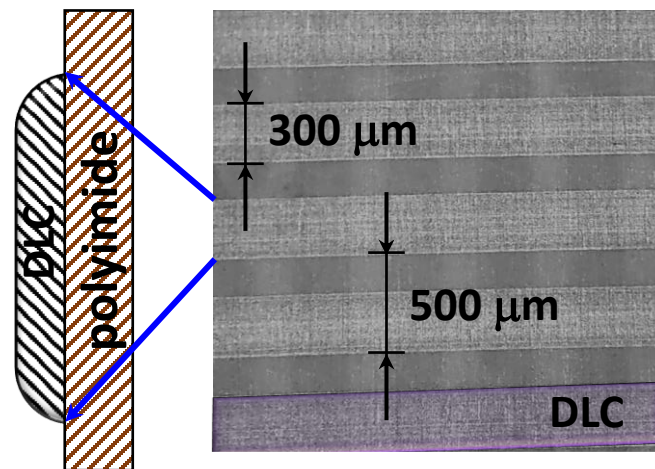
Structured DLC anode (photo-lithography assisted PVD deposition of carbon) – thin coating (100 nm) deposited in **National Academy of Sciences of Belarus** for Micromegas R&D for TPC MPD NICA



# Structured DLC anode for MicroMegas

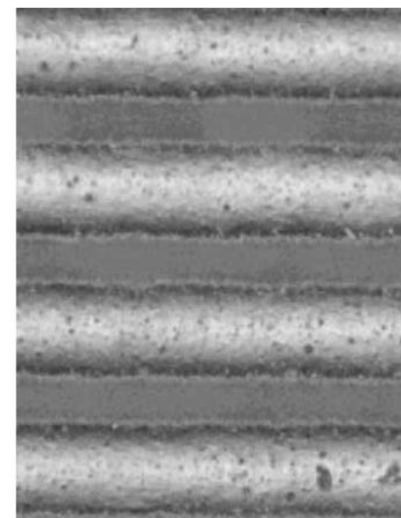
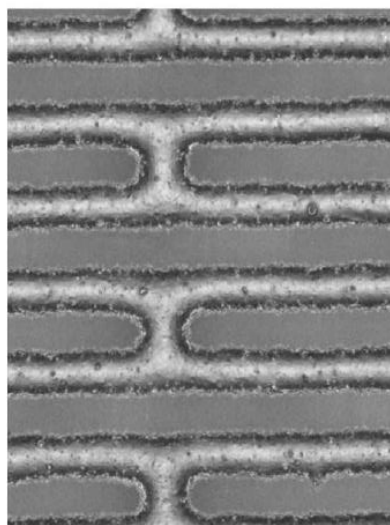


Structured resistive anode (screen-printing of resistive paste) in Micromegas chambers for the ATLAS New Small Wheel



Structured DLC anode made in Japan (OCHI Atsuhiko KOBE university)

<https://agenda.infn.it/event/7618/contributions/69161/attachments/50258/59384/DeOliveira.pdf>



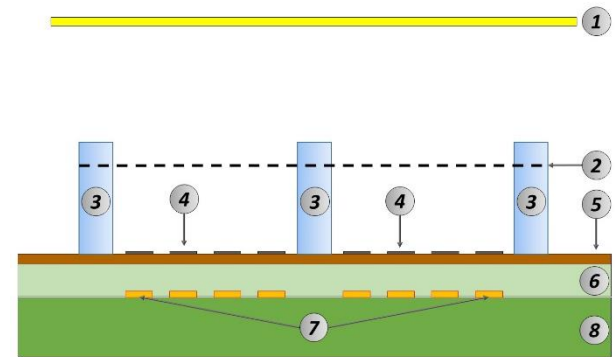
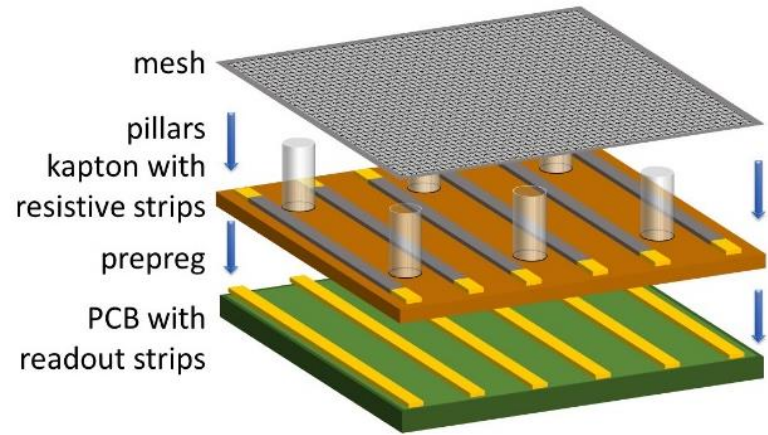
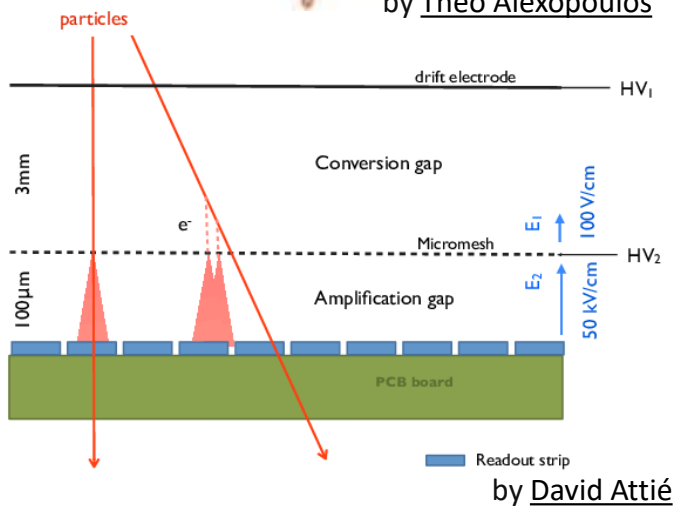
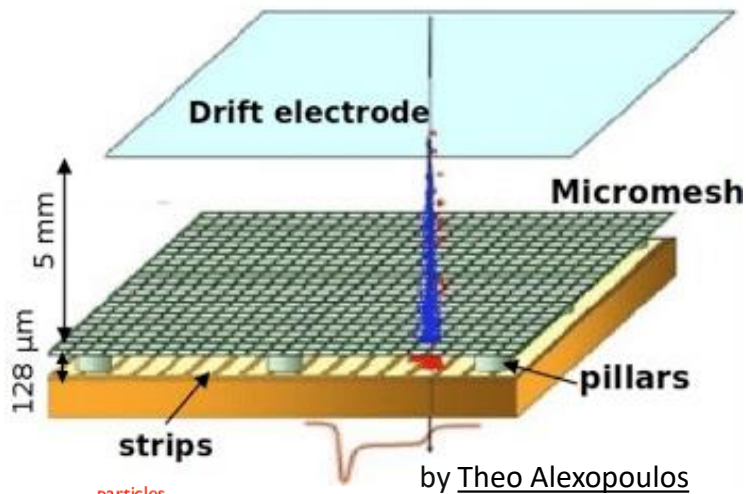
Structured DLC anode for MicroMegas R&D for muon imaging (CEA - Irfu, University Paris-Saclay)

[https://indico.cern.ch/event/676702/contributions/12723/attachments/1575460/2487710/Micromegas\\_RD\\_for\\_muon\\_imaging\\_activities\\_at\\_Saclay.pdf](https://indico.cern.ch/event/676702/contributions/12723/attachments/1575460/2487710/Micromegas_RD_for_muon_imaging_activities_at_Saclay.pdf)



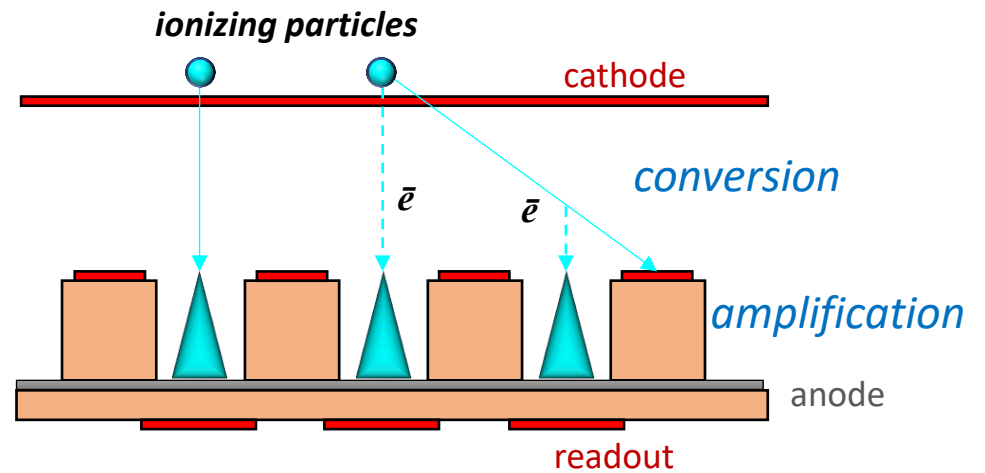
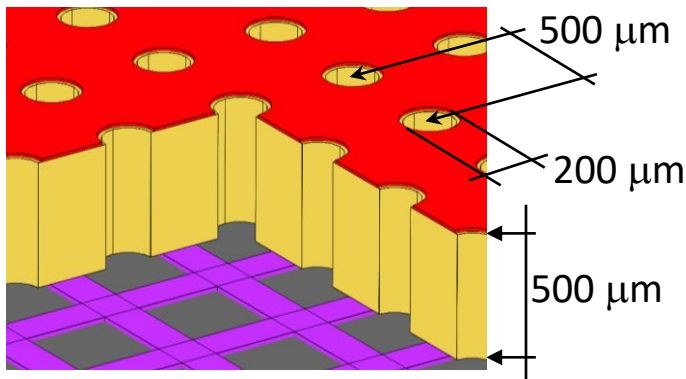
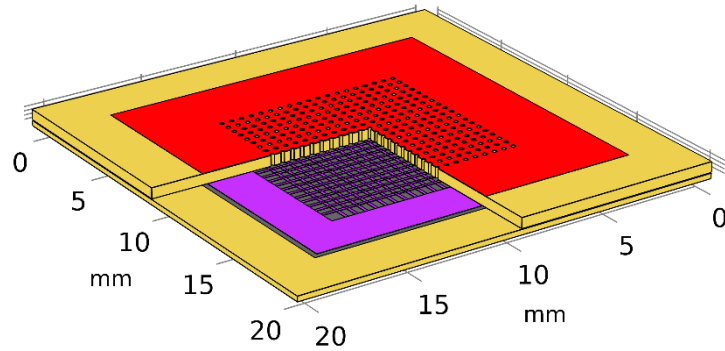
# Current Activity

- Improving of arc-PVD method for DLC deposition (sheet resistivity, large area, composite structure)
- Bulk MicroMegas detector with resistive DLC anode for R/O Chambers of TPC @ NICA MPD experiment (Phase II)
- Cylindrical MicroMegas detector with resistive DLC anode for Vertex Detector @ NICA SPD experiment (Phase I)
- R-WEM detector with DLC anode and isolated HV-grid for R/O Chambers of TPC @ NICA MPD experiment
- Hybrid R-WEM & MicroMegas (Double MM) detector with extra low Ion Back Flow
- Ultra Thin MicroMegas detector for diagnostics of the secondary beam at the ACCULINNA-2 fragment separator for the Dubna SuperHeavy Element Factory
- Meta-structures for MPGDs adaptation to R/O Chambers of TPC for MPD experiment
  - ✓ Principe of Large Pads with Capacitive Sharing: Charge-to-Digital-Converter (QDC)
  - ✓ Composite anode-readout pad plane structures with patterned resistive layer for Charge Dispersion method of signal readout: Time-to-Digital-Converter (TDC)
  - ✓ QDC-TDC Hybrid Meta-Structures



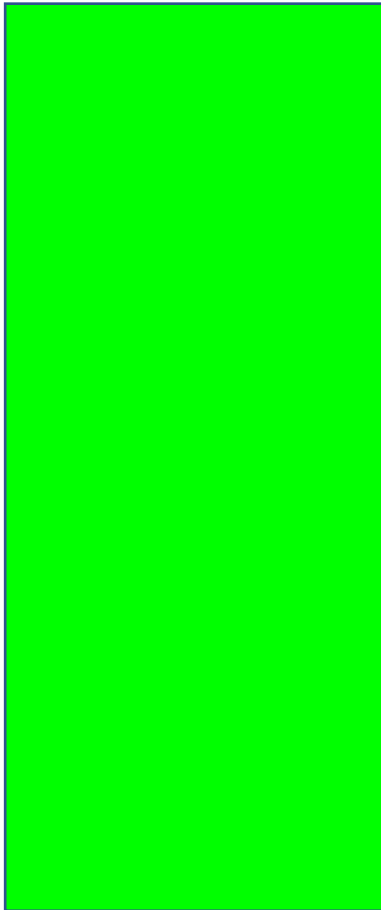
- (1) – катод, (2) – металлическая сетка,  
 (3) – поддерживающие столбики (пиллары),  
 (4) – резистивные полосы из износостойкого углерода,  
 (5) – слой полиимида,  
 (6) – слой препрега,  
 (7) – считывающие электроды на печатной плате (8)

# Resistive Well Electron Multiplier (R-WEM)

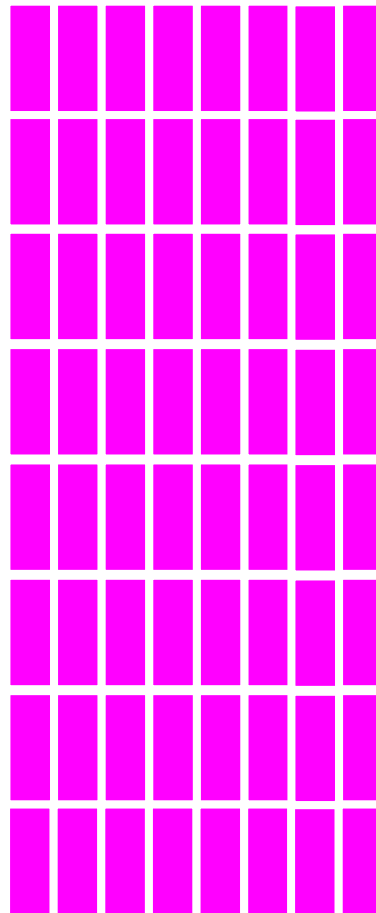




Pad 5mm X 12 mm



Pad 0.625mm X 1.5mm



**For Pads**

**625 $\mu$ m X 1.5mm**

**(spatial resolution  $\sim$ 200 $\mu$ m)**

**Number of  
channels**

**X 64**

**Number of Channels  
in TPC of MPD – 95,232**

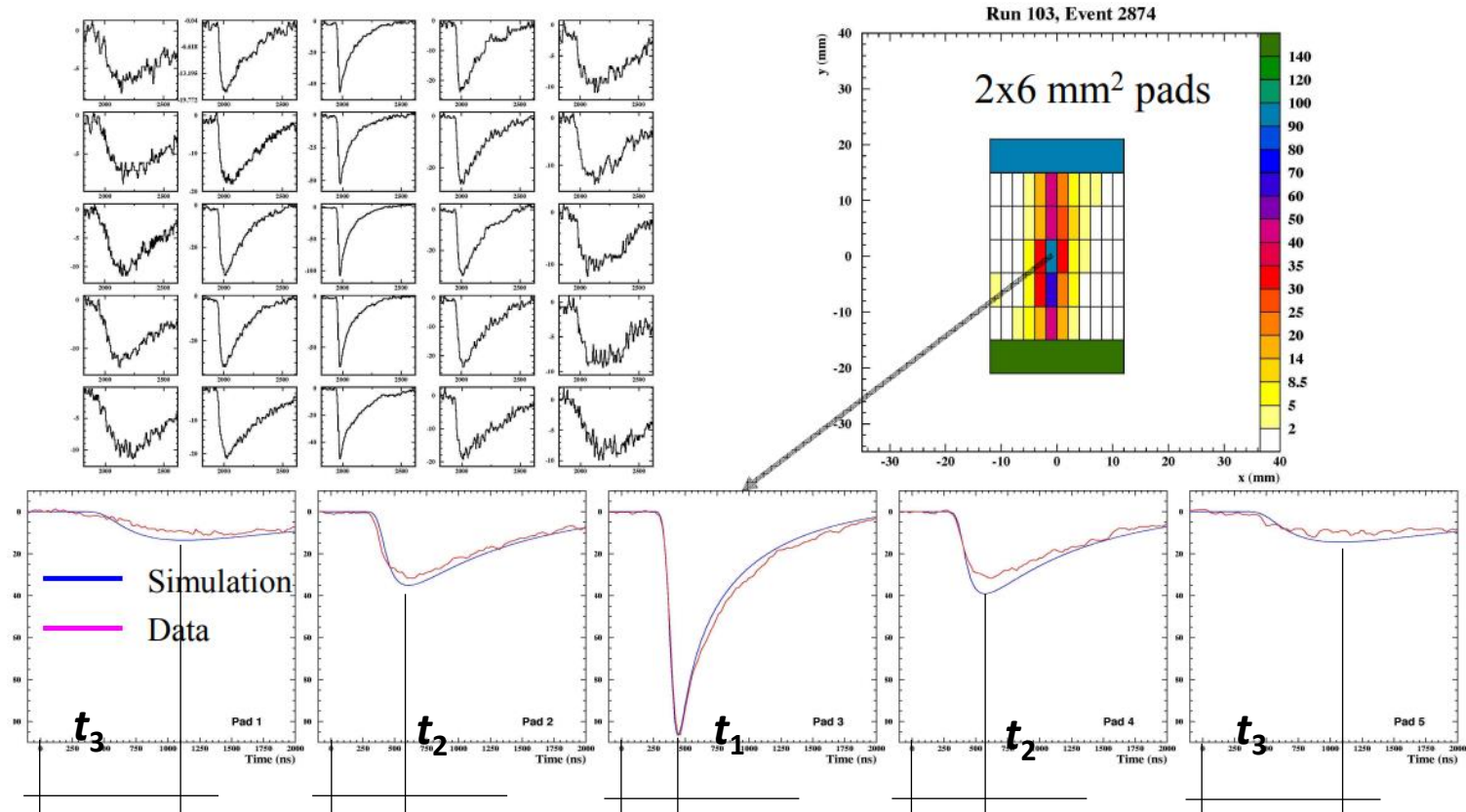
**For Pads 300 $\mu$ m X 750 $\mu$ m  
Number of channels X 256**

# Charge Dispersion Signal in Resistive Anode



M.S. Dixit et al. Position sensing from charge dispersion in micro-pattern gaseous detectors with a resistive anode.  
*NIMA* 518 (2004) 721

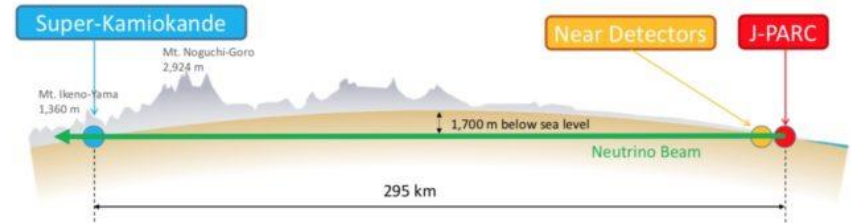
*Madhu Dixit* Carleton University & TRIUMF, Canada



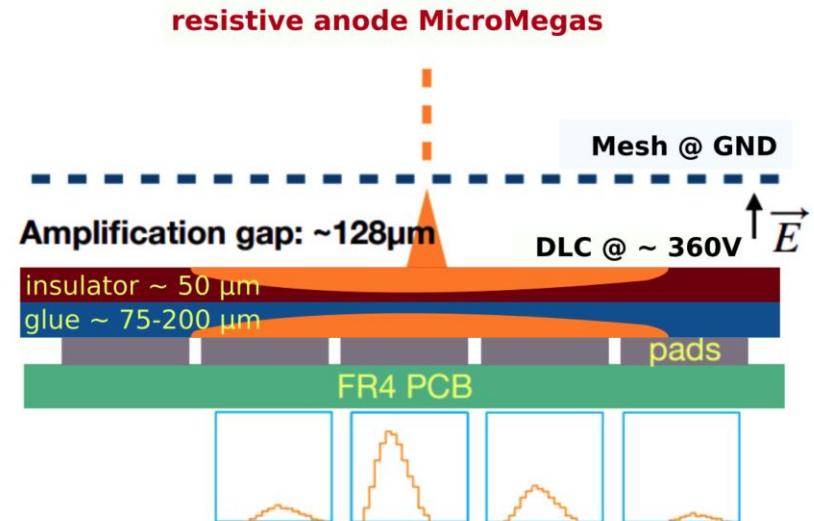
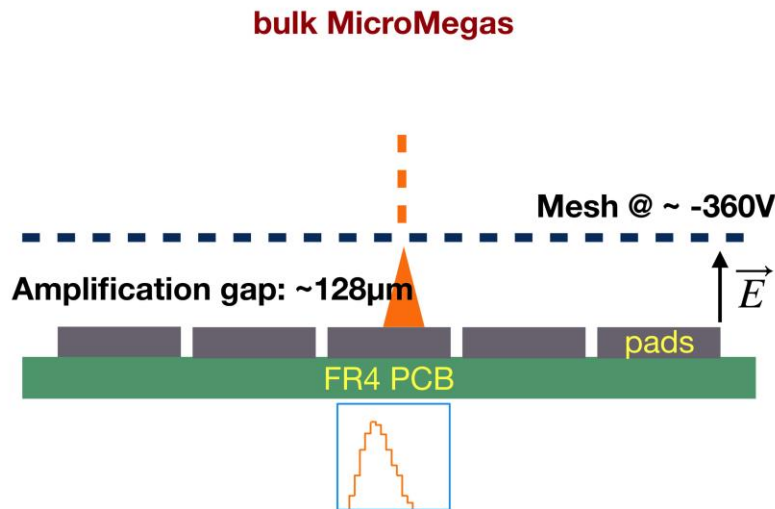
# Charge Dispersion Signal in Resistive Anode

## The approach of charge dispersion

will be used for the upgrade of the Near Detector (ND280) in neutrino T2K experiment (Tokai to Kamioka), Japan



Resistive Micromegas detectors for the upgrade of the T2K Near Detector Time Projection Chambers.  
Spatial resolution up to  $200\ \mu\text{m}$  for  $0.97 \times 0.69\ \text{cm}^2$  pads





# Capacitive Sharing Large Pad Readout



Photo from The 6th  
International Conference on  
Micro Pattern Gaseous  
Detectors, MPGD19

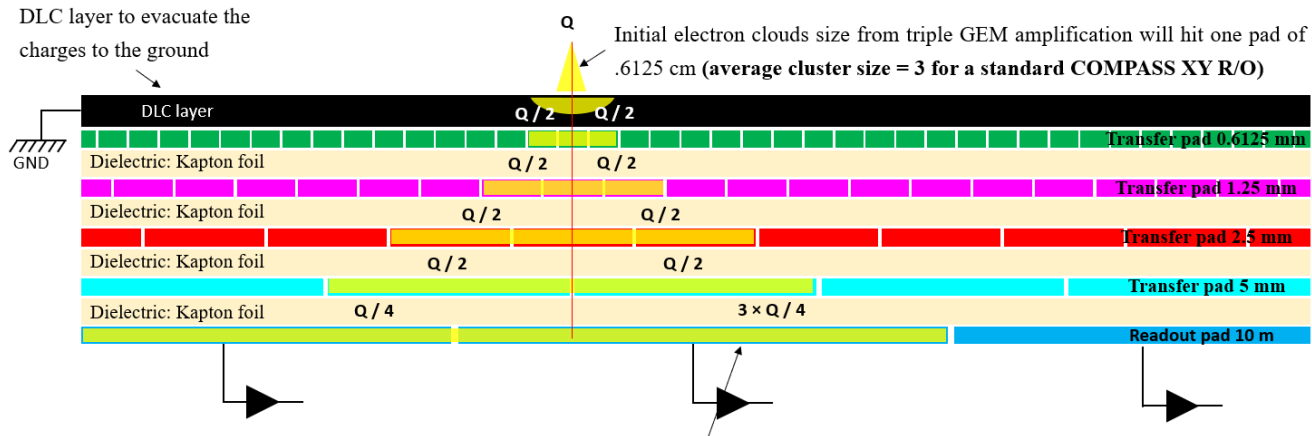
The idea was proposed in **2020** by **Kondo Gnanvo**,  
University of Virginia, Charlottesville, VA, USA



**Capacitive Sharing Large Pad Readout** is  
supposed to be implemented in:

- **CLAS12 experiment** - Upgrade for High Luminosity Operations,  
**CEBAF Large Acceptance Spectrometer**,  
Jefferson Laboratory, Newport News, Virginia, United States
- **The Electron-Ion Collider** that will be build on the base of  
**Brookhaven's Relativistic Heavy Ion Collider (RHIC)**,  
Upton, New York, United States

# Capacitive Sharing Large Pad Readout



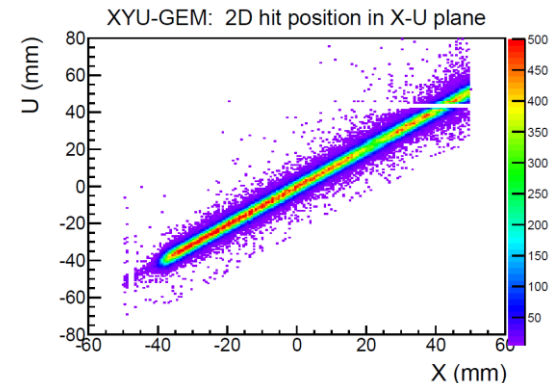
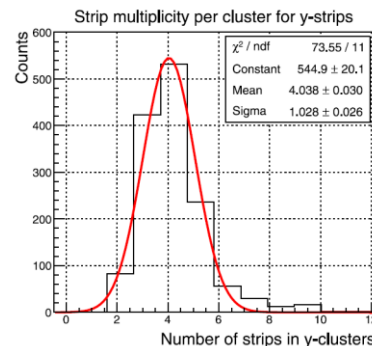
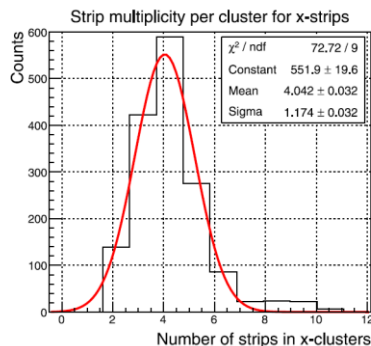
2 large pads (1 cm<sup>2</sup>) share the initial charges: **position is the weighted average of the pads** ⇒ expected similar performances in spatial resolution as a COMPASS X/Y strip readout but with only 100 pads to read out instead of 512 for a COMPASS XY readout

## First Results:

RD51 Collaboration, 06/26/2020

K. Gnanvo, N. Liyanage, B. Mehl, Rui de Oliveira *NIMA* **1047** (2023) 167782

K. Gnanvo et al. *NIMA* **1066** (2024) 169654



For two transfer layers of pads with pitch of 400 and 800 μm spatial resolution is  $56.2 \pm 0.9 \mu\text{m}$

# Capacitive Sharing Large Pad Readout



The 8<sup>th</sup> International Conference on Micro-Pattern Gaseous Detectors  
Oct.14<sup>th</sup> - Oct.18<sup>th</sup> 2024 USTC-Hefei, China

## Resistive High Granularity Micromegas for Future Detectors. Status and Perspectives

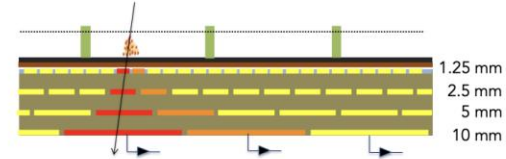
M. ALVIGGI<sup>1,2</sup>, M. BIGLIETTI<sup>3</sup>, M.T. CAMERLINGO<sup>5</sup>,  
K. CHMIEL<sup>3,4</sup>, M. DELLA PIETRA<sup>1,2</sup>, C. DI DONATO<sup>1,7</sup>,  
R. DI NARDO<sup>3,4</sup>, P. IENGO<sup>1</sup>, M. IODICE<sup>3</sup>,  
R. ORLANDINI<sup>3,4</sup>, S. PERNA<sup>1,2</sup>, F. PETRUCCI<sup>3,4</sup>,  
G. SEKHNIAIDZE<sup>1</sup>, M. SESSA<sup>5</sup>

<sup>1</sup> INFN Napoli,  
<sup>2</sup> Univ. di Napoli Federico II  
<sup>3</sup> INFN Roma Tre  
<sup>4</sup> Univ. Roma Tre  
<sup>5</sup> INFN Tor Vergata  
<sup>6</sup> INFN Bari, <sup>7</sup> Univ. di Napoli Parthenope

## Medium/Low-rate Version – Capacitive Sharing

Concept from R. De Oliveira and K. Gnanvo et al., NIMA 1047 (2023) 167782)

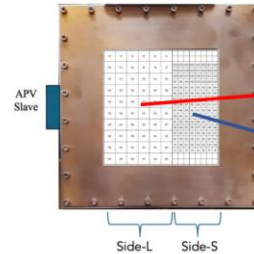
- First implementation of the capacitive sharing principle in a single layer DLC resistive Micromegas
- Charge shared in large readout pads through the capacitive coupling between stack of layers of pads.
  - Good spatial resolution and reduction of the readout channels
- Suitable for low- medium- rate applications



- Pad size of "top-layer" (signal induction): 1.25x1.25 mm<sup>2</sup>

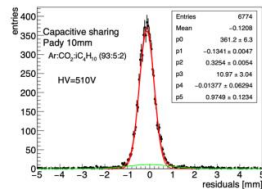
- **Side-L:** Four layers capacitive sharing: 1.25x1.25 mm<sup>2</sup> → 2.5x2.5 mm<sup>2</sup> → 5x5 mm<sup>2</sup> → **10x10 mm<sup>2</sup>**

- **Side-S:** three layers capacitive sharing: 1.25x1.25 mm<sup>2</sup> → 2.5x2.5 mm<sup>2</sup> → **5x5 mm<sup>2</sup>**

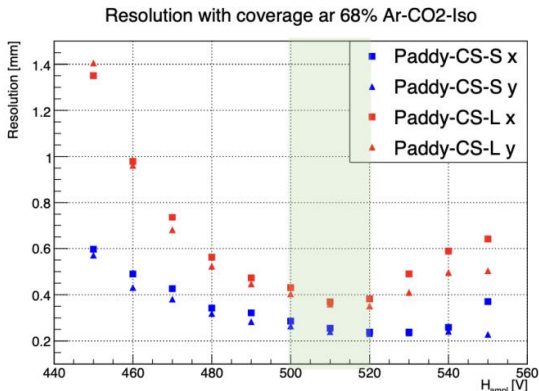


## Capacitive Sharing Test-Beam Results

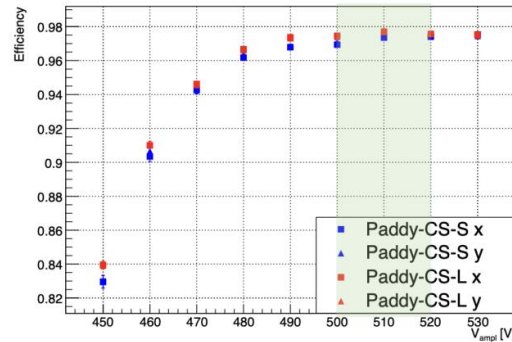
Resolution: half-width of the distribution retaining 68% of the events



## Spatial Resolution and Efficiency



Efficiencies Ar-CO2-Iso



REACH ~380 μm with 10x10 mm<sup>2</sup> pads

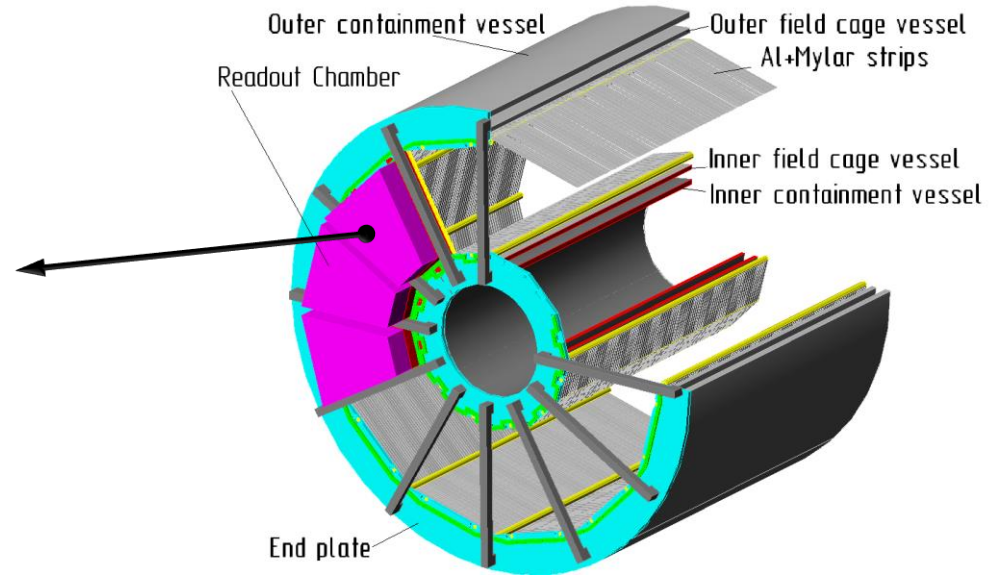
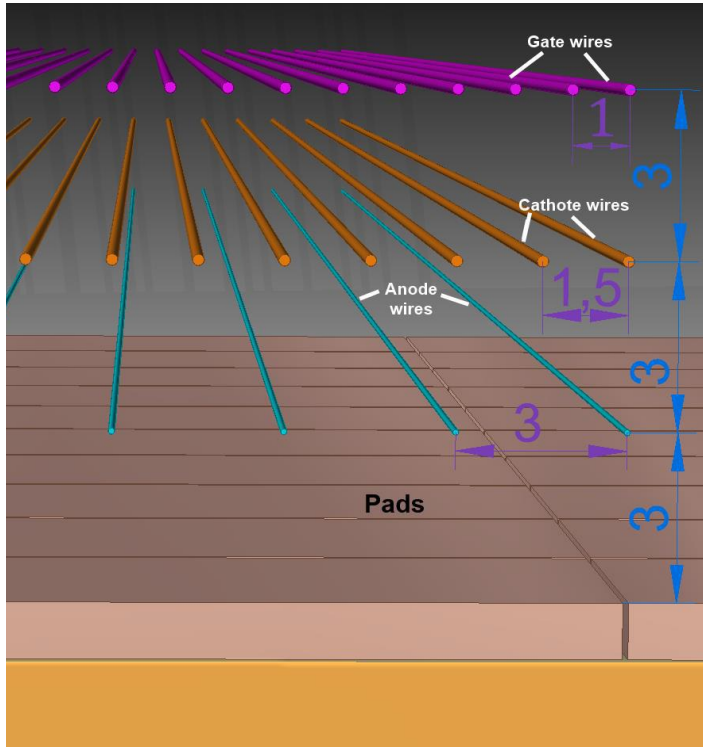
→ A factor 1/26 of the pad size

~220 μm with 5x5 mm<sup>2</sup> pads (1/23 of the pad size)



# Read-Out Chamber of 1<sup>st</sup> Stage of NICA MPD Experiment

## MultiWire Proportional Chamber (MWPC) with Gating Grid System



At the 2d Stage of NICA MPD Experiment the Luminosity will be increased. It means that Event Rate of R/O Chambers should be also increased → Upgrade by use of

**Micro Pattern Gaseous Detectors (MPGDs)**

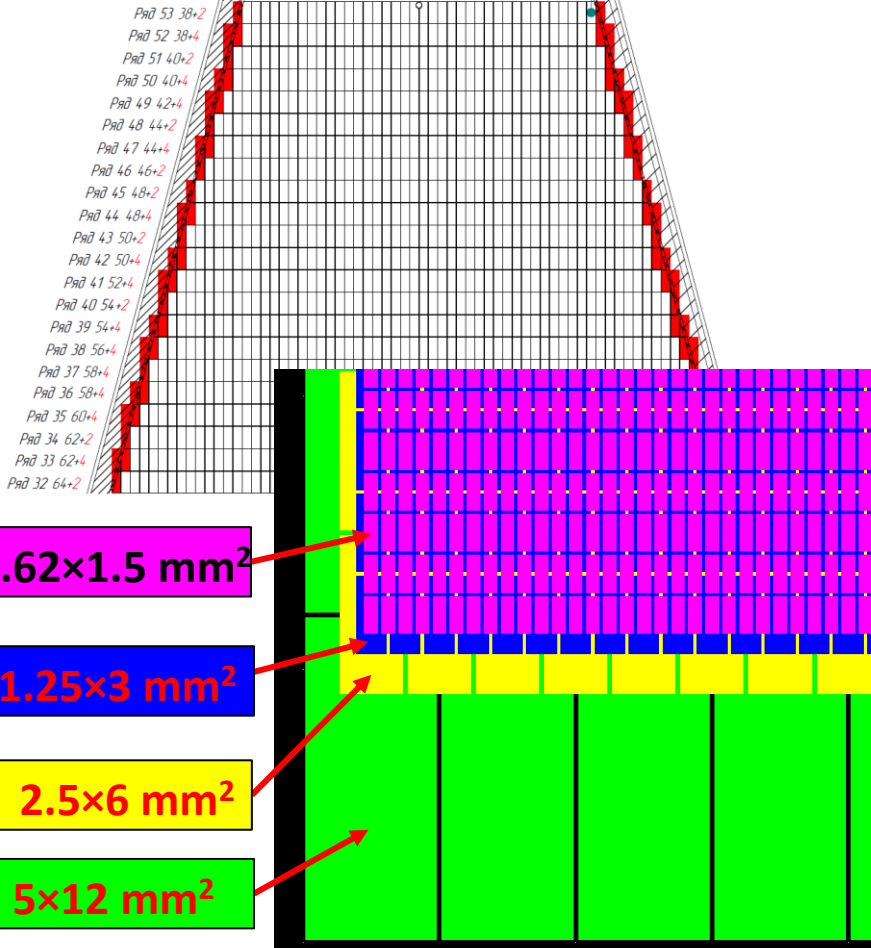
Parameter of 1 <sup>st</sup> Stage	Value
Length of the TPC	340cm
Outer radius of vessel	140cm
Inner radius of vessel	27 cm
Maximum beam-beam event rate	5 kHz
Luminosity	$1 \cdot 10^{27} \text{ cm}^{-2}\text{s}^{-1}$
Gas amplification factor	10,000

# MPGD adaptation to R/O Chambers of TPC of MPD experiment

## Capacitive Sharing readout PCB

### MPD TPC PAD PLANE

Small pads  $5 \times 12 \text{ mm}^2$   $2 \text{ min} = 56.64 \text{ mm}^2$  (97.7%)



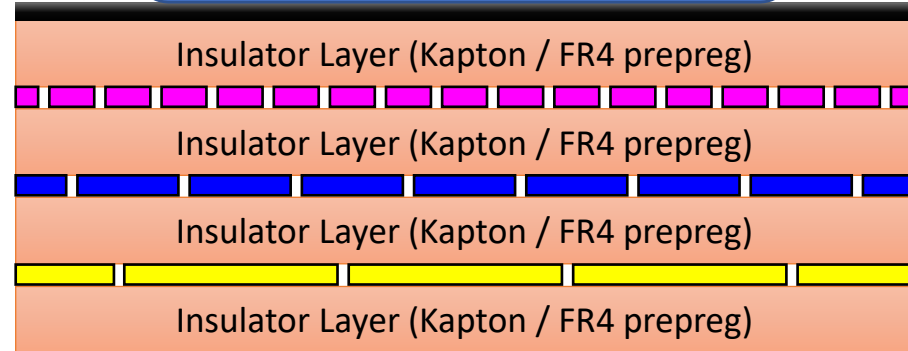
MPGD:

MicroMegas

R-WEM

R-WEM + MicroMegas

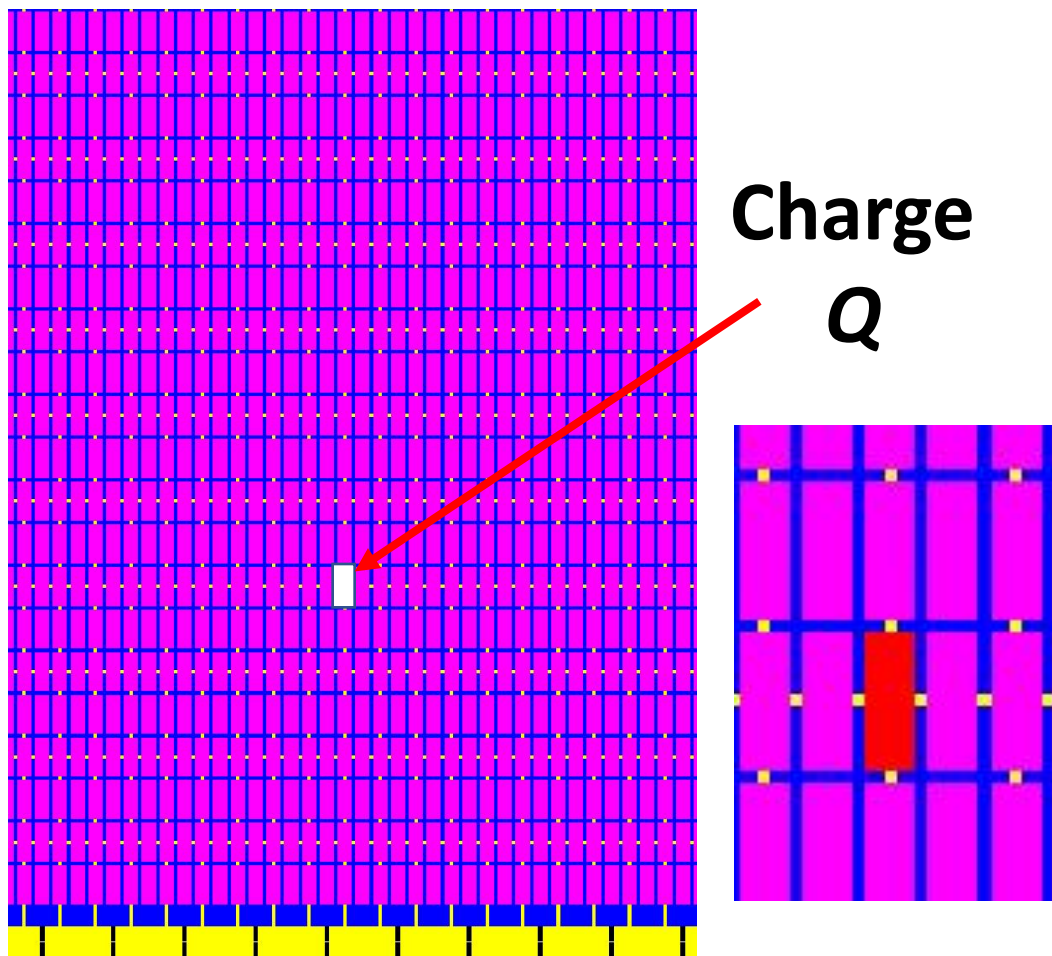
DLC Layer



MPD TPC PAD PLANE

# How the Principle of Large Pads with Capacitive Sharing Works

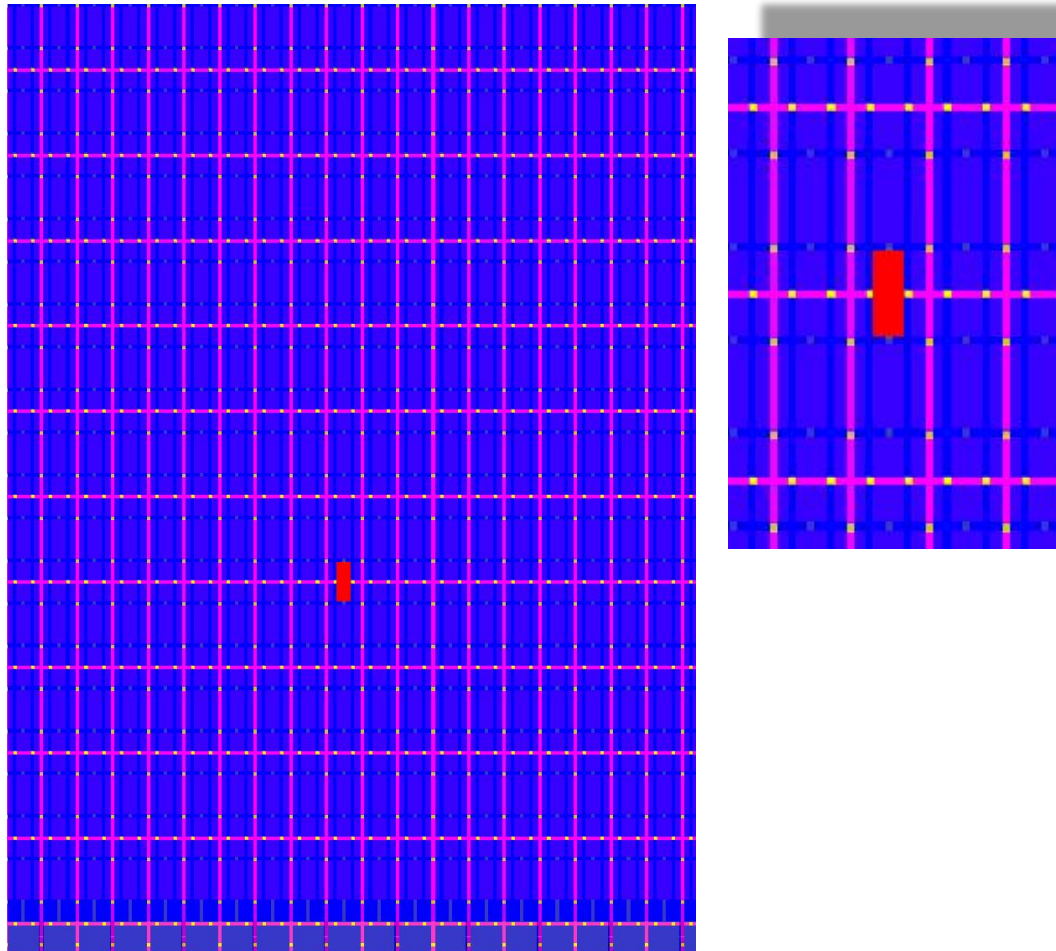
0.62×1.5 mm<sup>2</sup>





# How the Principle of Large Pads with Capacitive Sharing Works

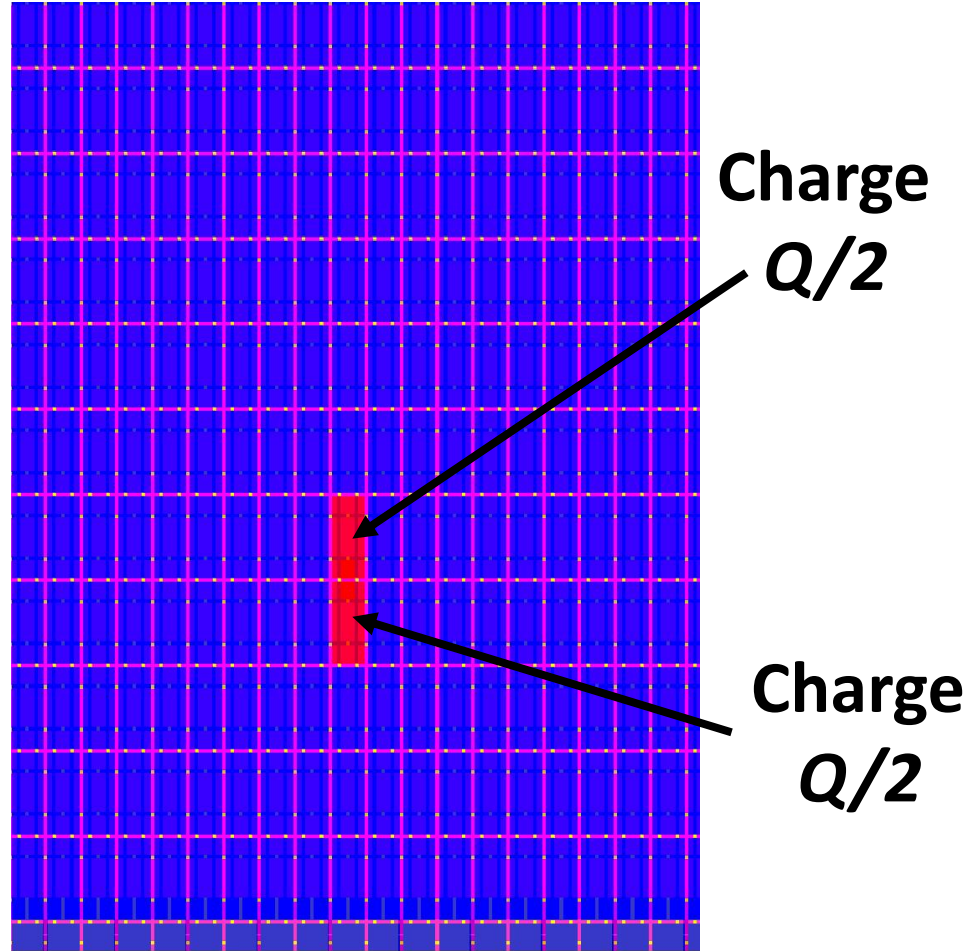
1.25×3 mm<sup>2</sup>



Capacitive Sharing with 2 pads at next Layer

# How the Principle of Large Pads with Capacitive Sharing Works

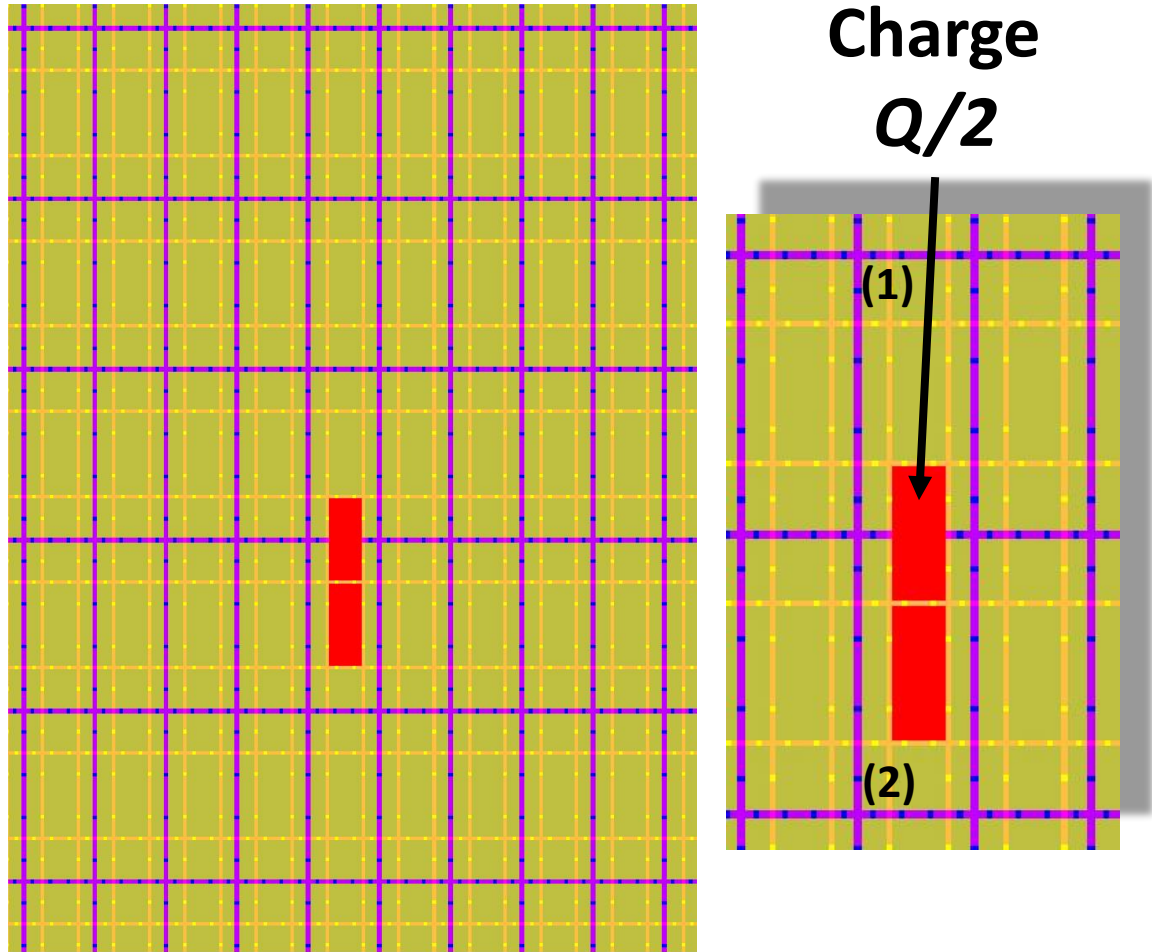
1.25×3 mm<sup>2</sup>



Each pad at 2d Layer with charge  $Q/2$

# How the Principle of Large Pads with Capacitive Sharing Works

2.5×6 mm<sup>2</sup>

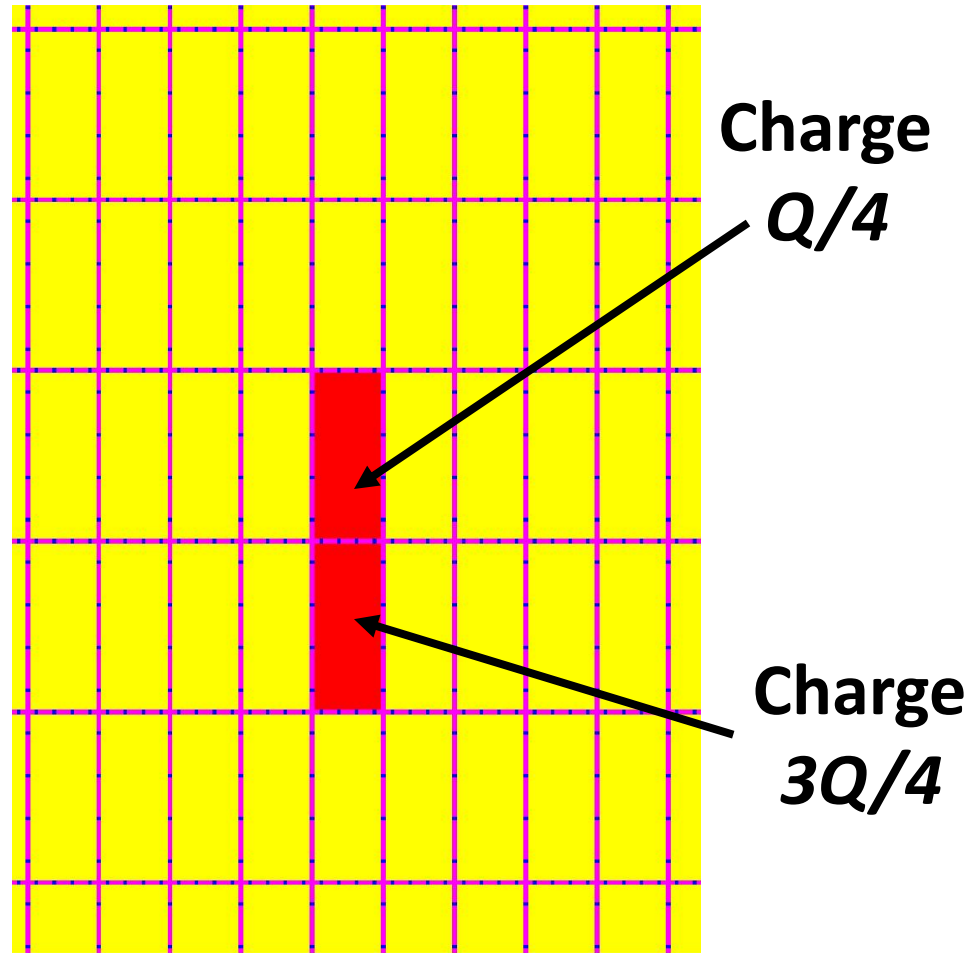


One pad at 3d Layer will be charged with  $(Q/2)/2$   
The second as  $Q/2 + (Q/2)/2$



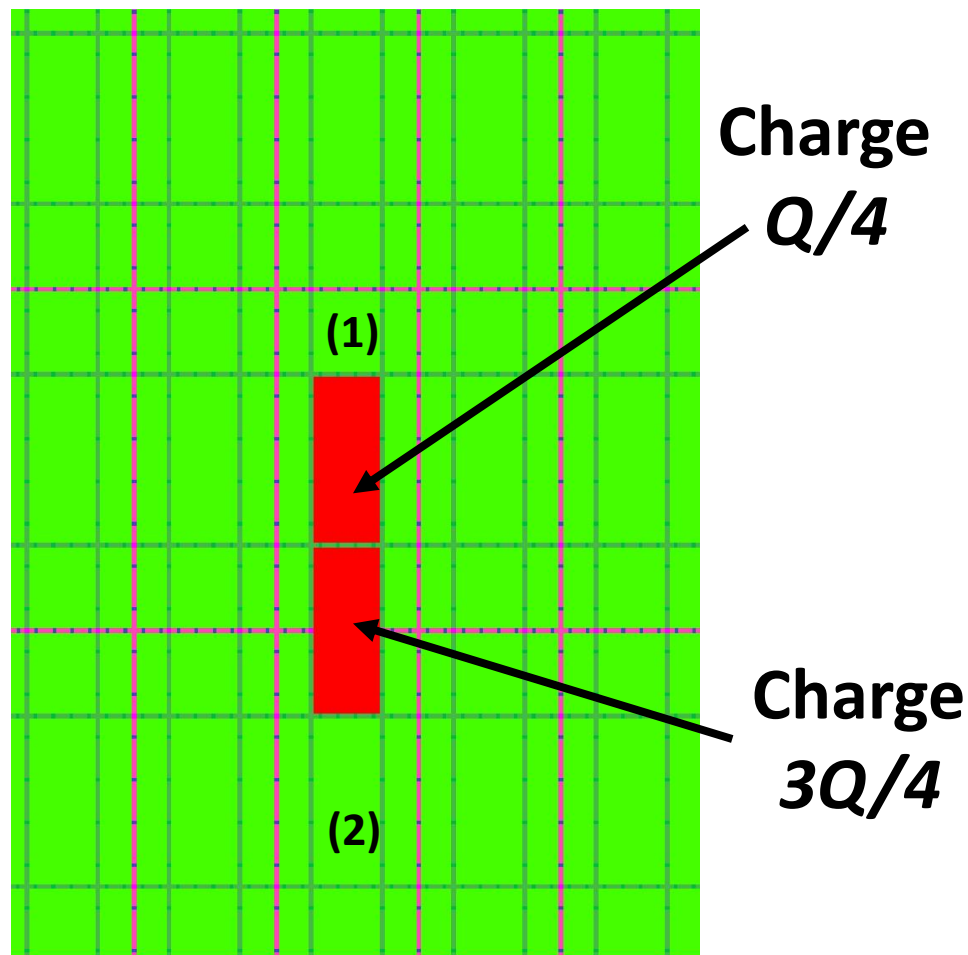
# How the Principle of Large Pads with Capacitive Sharing Works

2.5×6 mm<sup>2</sup>



# How the Principle of Large Pads with Capacitive Sharing Works

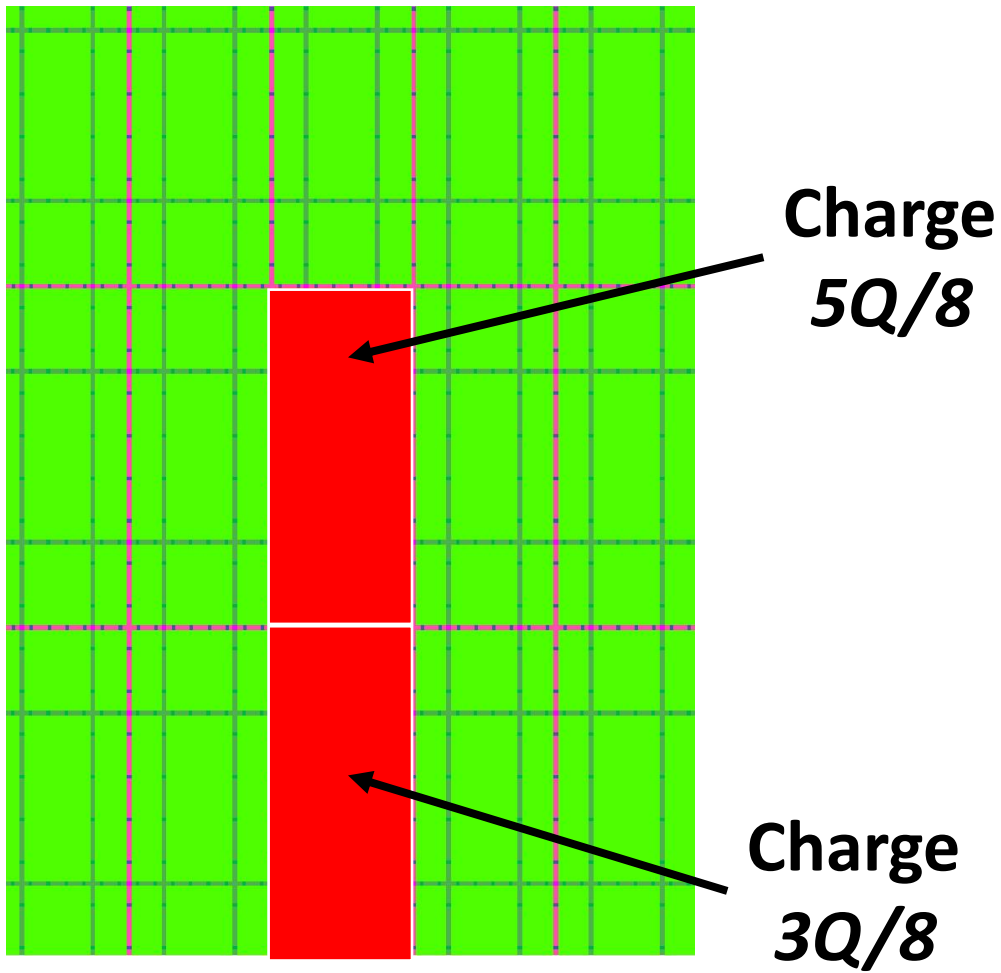
5×12 mm<sup>2</sup>



- 1) First pad at MPD TPC PAD PLANE will be charged with  $(Q/4) + (3Q/4)/2$
- 2) The second as  $(3Q/4)/2$

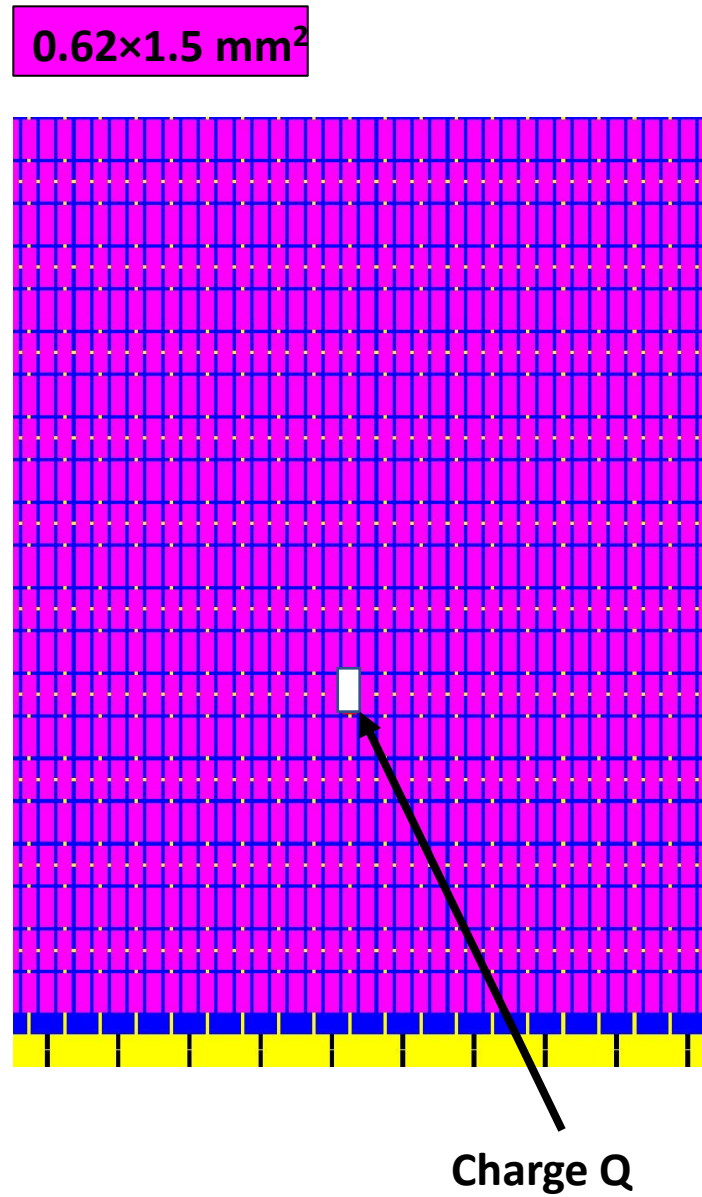
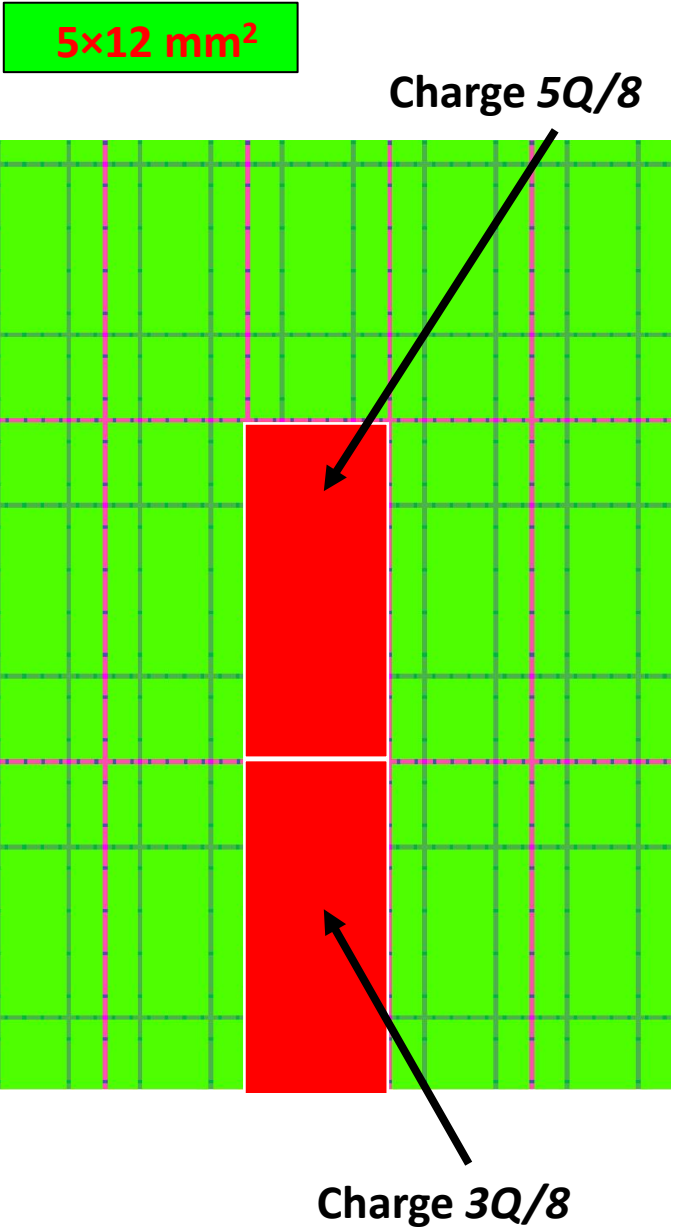
# How the Principle of Large Pads with Capacitive Sharing Works

5x12 mm<sup>2</sup>





# How the Principle of Large Pads with Capacitive Sharing Works

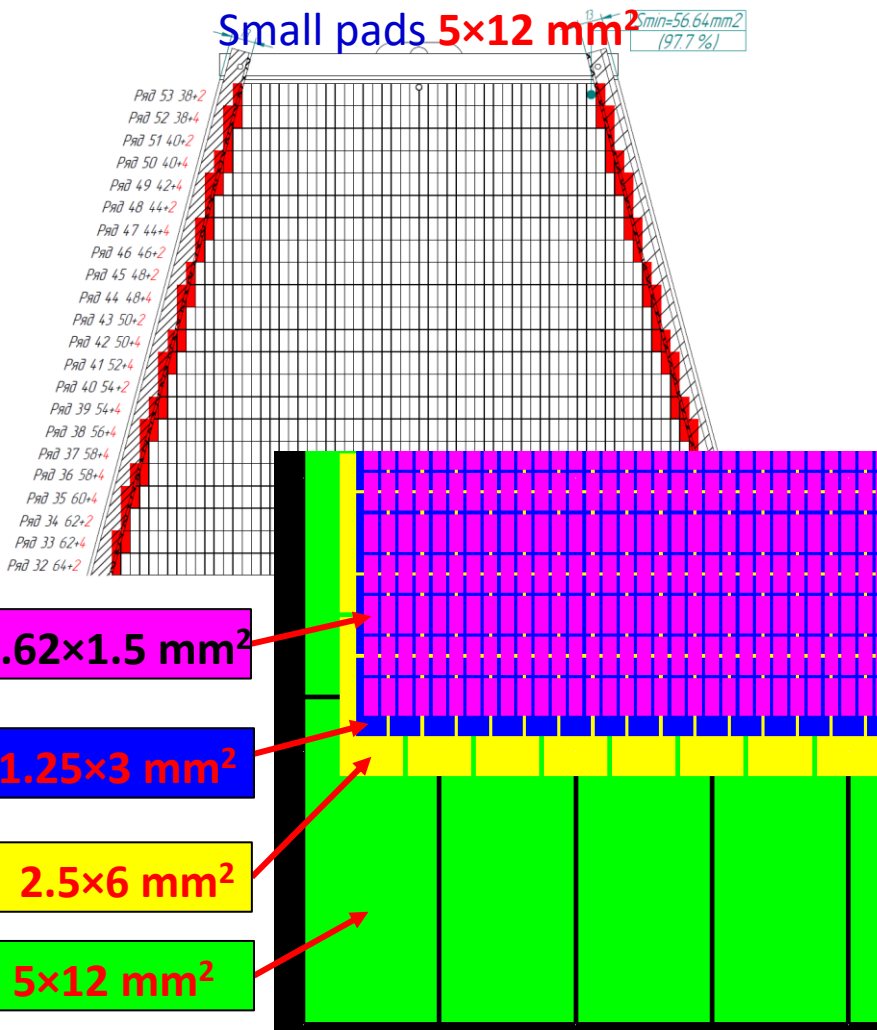


# MPGD adaptation to R/O Chambers of TPC of MPD experiment

## Capacitive Sharing readout PCB

### MPD TPC PAD PLANE

Small pads  $5 \times 12 \text{ mm}^2$   $2 \text{ min} = 56.64 \text{ mm}^2$  (97.7%)



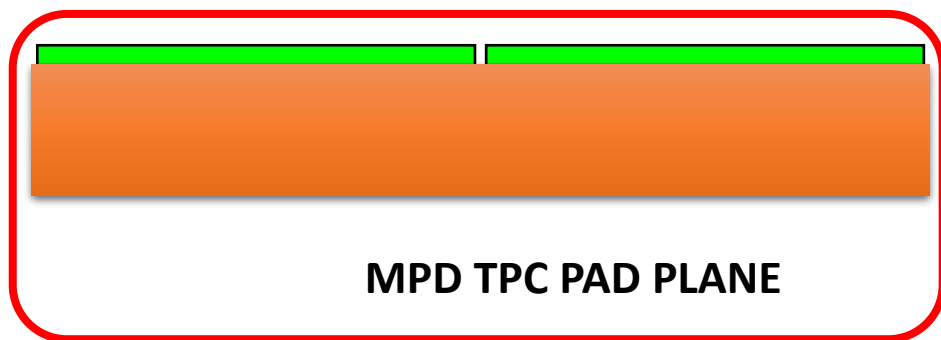
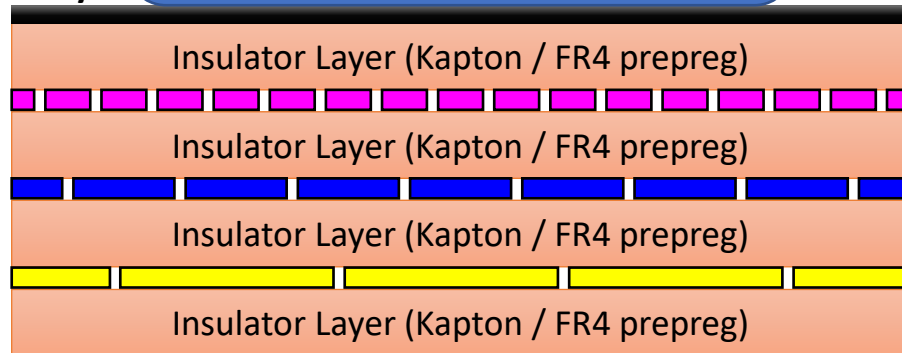
MPGD:

MicroMegas

R-WEM

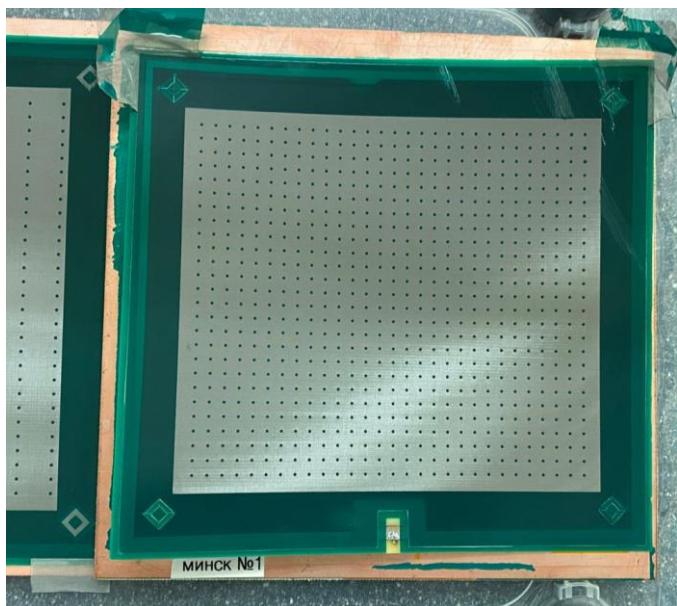
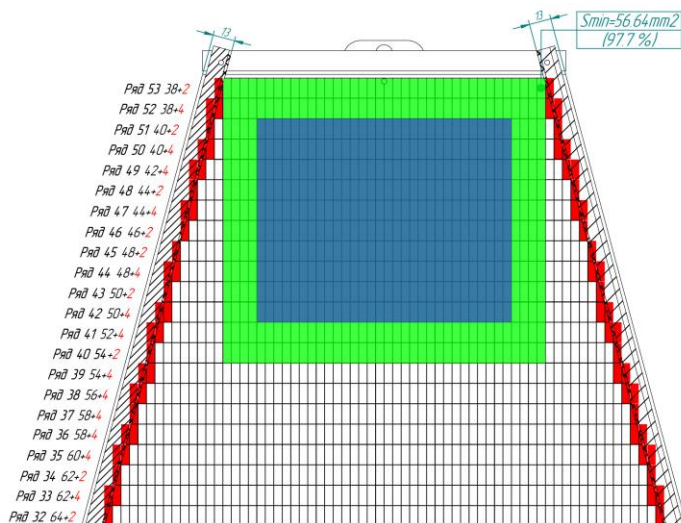
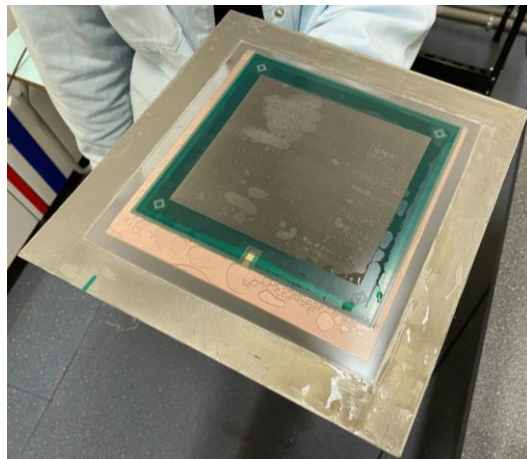
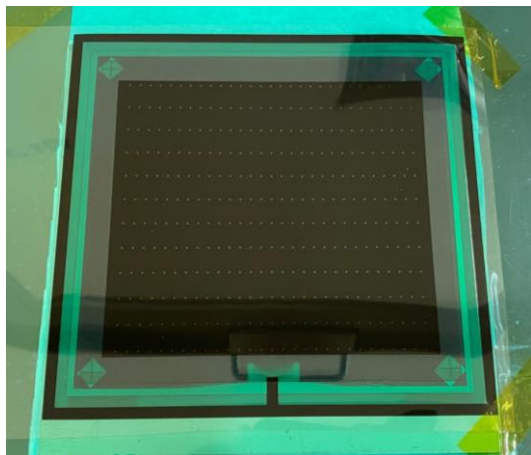
R-WEM + MicroMegas

DLC Layer



MPD TPC PAD PLANE

# Prototypes of MicroMegas detector with Capacitive Sharing Pad Readout for TPC @ MPD experiment at NICA



**Active area  
137mm X 152mm**